

# MOS INTEGRATED CIRCUIT $\mu$ PD16682A

# 1/65 DUTY LCD CONTROLLER/DRIVER WITH ON-CHIP RAM

# DESCRIPTION

The  $\mu$  PD16682A is a LCD controller/driver that includes enough RAM capacity to drive full-dot LCD displays. Each chip can drive a full-dot LCD display consisting of up to 132 x 65 dots.

This chip is suitable for cellular phones, Japanese or Chinese-language pagers, and other devices that display Japanese or Chinese characters using either 16 x 16 or 12 x 12 dots per character.

# FEATURES

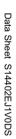
- LCD controller/driver with on-chip display RAM
- Able to operate using +3-V single power supply
- On-chip booster circuit: switchable between 3x and 4x modes
- RAM for dot displays: 132 x 65 bits
- Outputs : 132 segments, 65 commons
- Serial or 8-bit parallel data inputs (switchable between 80 and 68 series CPUs)
- On-chip divider resistor
- Selectable bias settings (can be set as 1/9 or 1/7 bias)
- On-chip oscillation circuit

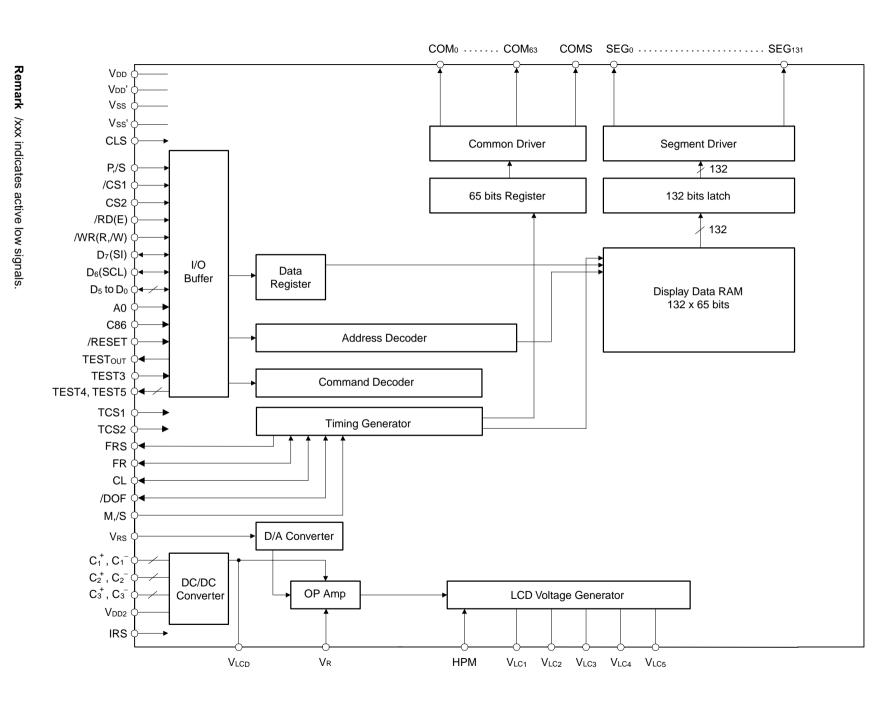
# **\*** ORDERING INFORMATION

Part number	Package
$\mu$ PD16682AW	Wafer
$\mu$ PD16682AP	Chip

**Remark** Purchasing the above products in term of chips per requires an exchange of other documents as well, including a memorandum on the product quality. Therefore those who are interested in this regard are advised to contact one of our sales representatives.

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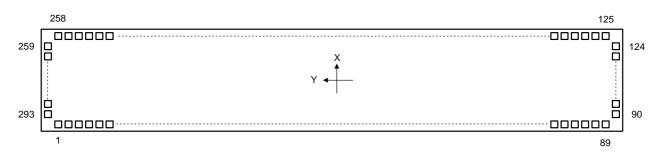
1. BLOCK DIAGRAM

Z

<u> μ</u>PD16682A

# 2. PIN CONFIGURATION (Pad Layout)

Chip Size : 2.66 x 9.84 mm<sup>2</sup>



Pad No.	Pad Name	Χ [μm]	Υ [ <i>μ</i> m]	Pad Type	Pad No.	Pad Name	Χ [μm]	Υ [ <i>μ</i> m]	Pad Type
1	DUMMY1	-1197.68	3984.44	C	59	VLC5	-1197.68	-1268	В
2	FRS	-1197.68	3862	В	60	VLC5	-1197.68	-1358	В
3	FR	-1197.68	3772	В	61	VLC4	-1197.68	-1448	В
4	CL	-1197.68	3682	В	62	VLC4	-1197.68	-1538	В
5	/DOF	-1197.68	3592	В	63	VLC3	-1197.68	-1628	В
6	TESTOUT	-1197.68	3502	В	64	VLC3	-1197.68	-1718	В
7	Vss'	-1197.68	3412	В	65	VLC2	-1197.68	-1808	В
8	/CS1	-1197.68	3322	B	66	VLC2	-1197.68	-1898	В
9	CS2	-1197.68	3232	В	67	VLC1	-1197.68	-1988	В
10	V <sub>DD</sub> '	-1197.68	3142	B	68	VLC1	-1197.68	-2078	B
11	/RESET	-1197.68	3052	B	69	VR	-1197.68	-2168	B
12	A0	-1197.68	2962	B	70	VR	-1197.68	-2258	B
13	Vss'	-1197.68	2872	B	71	Vss'	-1197.68	-2348	B
14	/WR(R,/W)	-1197.68	2782	B	72	Vss Vss'	-1197.68	-2438	B
14	/WR(R,/W) /RD(E)	-1197.68	2692	-	72	TCS1	-1197.68	-2528	B
	( )			B					-
16	Vdd'	-1197.68	2602	B	74	TCS2	-1197.68	-2618	B
17	Do	-1197.68	2512	B	75	TEST3	-1197.68	-2708	B
18	D1	-1197.68	2422	В	76	TEST4	-1197.68	-2798	B
19	D2	-1197.68	2332	В	77	TEST5	-1197.68	-2888	B
20	D <sub>3</sub>	-1197.68	2242	В	78	VDD'	-1197.68	-2978	В
21	D4	-1197.68	2152	В	79	M,/S	-1197.68	-3068	В
22	D₅	–1197.68	2062	В	80	CLS	-1197.68	-3158	В
23	D <sub>6</sub> (SCL)	–1197.68	1972	В	81	Vss'	-1197.68	-3248	В
24	D7(SI)	-1197.68	1882	В	82	C86	-1197.68	-3338	В
25	Vdd	-1197.68	1792	В	83	P,/S	-1197.68	-3428	В
26	Vdd	-1197.68	1702	В	84	Vdd'	-1197.68	-3518	В
27	Vdd	-1197.68	1612	В	85	HPM	-1197.68	-3608	В
28	Vdd2	-1197.68	1522	В	86	Vss'	-1197.68	-3698	В
29	Vdd2	-1197.68	1432	В	87	IRS	-1197.68	-3788	В
30	VDD2	-1197.68	1342	В	88	Vdd'	-1197.68	-3878	В
31	VDD2	-1197.68	1252	В	89	DUMMY2	-1197.68	-4000.44	С
32	Vss	-1197.68	1162	В	90	DUMMY3	-1032.44	-4787.68	С
33	Vss	-1197.68	1072	В	91	COM <sub>31</sub>	-940	-4787.68	Α
34	Vss	-1197.68	982	В	92	COM <sub>30</sub>	-880	-4787.68	Α
35	Vss	-1197.68	892	В	93	COM <sub>29</sub>	-820	-4787.68	Α
36	Vss	-1197.68	802	В	94	COM <sub>28</sub>	-760	-4787.68	А
37	Vss	-1197.68	712	В	95	COM <sub>27</sub>	-700	-4787.68	А
38	VLCD	-1197.68	622	B	96	COM <sub>26</sub>	-640	-4787.68	A
39	VLCD	-1197.68	532	B	97	COM <sub>25</sub>	-580	-4787.68	A
40	VLCD	-1197.68	442	B		COM <sub>24</sub>	-520	-4787.68	A
40	C1 <sup>+</sup>	-1197.68	352	B	99	COM <sub>23</sub>	-460	-4787.68	A
41	C1 C1 <sup>+</sup>	-1197.68	262	B	100		400 400	-4787.68	A
42	$C_1$ $C_1^-$	-1197.68	172	В	100			-4787.68	
43	$C_1$ $C_1^-$		82	В	101				A
	$C_1$ $C_2^+$	-1197.68					-280	-4787.68	A
45		-1197.68	-8	B	103		-220	-4787.68	A
46	$C_2^+$	-1197.68	-98	В	104		-160	-4787.68	A
47	$C_2^{-}$	-1197.68	-188	B	105		-100	-4787.68	A
48	$C_2^-$	-1197.68	-278	В	106		-40	-4787.68	A
49	$C_3^+$	-1197.68	-368	В	107	COM <sub>15</sub>	20	-4787.68	A
50	C <sub>3</sub> <sup>+</sup>	-1197.68	-458	В	108	COM <sub>14</sub>	80	-4787.68	A
51	C3_	–1197.68	-548	В	109	COM <sub>13</sub>	140	-4787.68	A
52	C <sub>3</sub> <sup>-</sup>	–1197.68	-638	В	110	COM <sub>12</sub>	200	-4787.68	А
53	Vdd'	-1197.68	-728	В	111	COM11	260	-4787.68	Α
54	Vdd'	-1197.68	818	В	112	COM <sub>10</sub>	320	-4787.68	Α
55	Vrs	-1197.68	-908	В	113	COM <sub>9</sub>	380	-4787.68	А
56	Vrs	-1197.68	-998	В	114	COM8	440	-4787.68	А
57	Vss'	-1197.68	-1088	В	115	COM7	500	-4787.68	Α
	Vss'	-1197.68	-1178	В	116		560	-4787.68	Α

Table 2–1. Pad Layout (1/3)

Pad No.	Pad Name	Χ [μm]	Υ [ <i>μ</i> m]	Pad Type	Pad No.	Pad Name	X [μm]	Υ [ <i>μ</i> m]	Pad Type
117	COM <sub>5</sub>	620	-4787.68	A	175	SEG <sub>49</sub>	1197.68	-990.4	A
118	COM <sub>4</sub>	680	-4787.68	Α	176	SEG <sub>50</sub>	1197.68	-930.4	Α
119	COM <sub>3</sub>	740	-4787.68	Α	177	SEG51	1197.68	-870.4	Α
120	COM <sub>2</sub>	800	-4787.68	Α	178	SEG <sub>52</sub>	1197.68	-810.4	Α
121	COM <sub>1</sub>	860	-4787.68	Α	179	SEG53	1197.68	-750.4	Α
122	COMo	920	-4787.68	Α	180	SEG <sub>54</sub>	1197.68	-690.4	Α
123	COMS	980	-4787.68	A	181	SEG <sub>55</sub>	1197.68	-630.4	A
124	DUMMY4	1072.6	-4787.68	C	182	SEG <sub>56</sub>	1197.68	-570.4	A
125	DUMMY5	1197.68	-4022.84	C	183	SEG <sub>57</sub>	1197.68	-510.4	A
120	SEG <sub>0</sub>	1197.68	-3930.4	A	184	SEG <sub>58</sub>	1197.68	-450.4	A
120	SEG <sub>1</sub>	1197.68	-3870.4	A	185	SEG <sub>59</sub>	1197.68	-430.4	A
127	SEG <sub>2</sub>	1197.68	-3810.4	A	185	SEG <sub>60</sub>		-330.4	A
120	SEG <sub>2</sub> SEG <sub>3</sub>	1197.68	-3750.4		187	SEG <sub>60</sub>	1197.68 1197.68	-270.4	
				A					A
130	SEG4	1197.68	-3690.4	A	188	SEG <sub>62</sub>	1197.68	-210.4	A
131	SEG₅	1197.68	-3630.4	A	189	SEG63	1197.68	-150.4	A
132	SEG <sub>6</sub>	1197.68	-3570.4	A	190	SEG <sub>64</sub>	1197.68	-90.4	A
133	SEG7	1197.68	-3510.4	A	191	SEG <sub>65</sub>	1197.68	-30.4	A
134	SEG <sup>8</sup>	1197.68	-3450.4	Α	192	SEG <sub>66</sub>	1197.68	29.6	A
	SEG <sub>9</sub>	1197.68	-3390.4	Α	193	SEG <sub>67</sub>	1197.68	89.6	Α
136	SEG10	1197.68	-3330.4	A	194	SEG <sub>68</sub>	1197.68	149.6	Α
137	SEG11	1197.68	-3270.4	Α	195	SEG <sub>69</sub>	1197.68	209.6	Α
138	SEG <sub>12</sub>	1197.68	-3210.4	Α	196	SEG70	1197.68	269.6	A
139	SEG <sub>13</sub>	1197.68	-3150.4	Α	197	SEG71	1197.68	329.6	Α
140	SEG14	1197.68	-3090.4	Α	198	SEG72	1197.68	389.6	Α
141	SEG15	1197.68	-3030.4	Α	199	SEG73	1197.68	449.6	Α
142	SEG <sub>16</sub>	1197.68	-2970.4	Α	200	SEG74	1197.68	509.6	Α
143	SEG17	1197.68	-2910.4	Α	201	SEG75	1197.68	569.6	Α
144	SEG <sub>18</sub>	1197.68	-2850.4	Α	202	SEG <sub>76</sub>	1197.68	629.6	Α
145	SEG <sub>19</sub>	1197.68	-2790.4	Α	203	SEG77	1197.68	689.6	Α
146	SEG <sub>20</sub>	1197.68	-2730.4	Α	204	SEG <sub>78</sub>	1197.68	749.6	Α
147	SEG <sub>21</sub>	1197.68	-2670.4	Α	205	SEG79	1197.68	809.6	Α
148	SEG22	1197.68	-2610.4	Α	206	SEG <sub>80</sub>	1197.68	869.6	Α
149	SEG <sub>23</sub>	1197.68	-2550.4	A	207	SEG <sub>81</sub>	1197.68	929.6	A
150	SEG <sub>24</sub>	1197.68	-2490.4	A	208	SEG <sub>82</sub>	1197.68	989.6	A
	SEG <sub>25</sub>	1197.68	-2430.4	A	209	SEG <sub>83</sub>	1197.68	1049.6	A
152	SEG <sub>26</sub>	1197.68	-2370.4	A	210	SEG <sub>84</sub>	1197.68	1109.6	A
153	SEG <sub>27</sub>	1197.68	-2310.4	A	210	SEG85	1197.68	1169.6	A
153	SEG <sub>28</sub>	1197.68	-2250.4	A	211	SEG86	1197.68	1229.6	A
	SEG <sub>29</sub>	1197.68				SEG87		1229.0	
155			-2190.4	A	213		1197.68		A
	SEG30	1197.68	-2130.4	A		SEG88	1197.68	1349.6	A
	SEG <sub>31</sub>	1197.68	-2070.4	A	215	SEG89	1197.68	1409.6	A
	SEG <sub>32</sub>	1197.68	-2010.4	A	216	SEG90	1197.68	1469.6	A
	SEG <sub>33</sub>	1197.68	-1950.4	A	217	SEG <sub>91</sub>	1197.68	1529.6	A
	SEG <sub>34</sub>	1197.68	-1890.4	A	218	SEG <sub>92</sub>	1197.68	1589.6	A
	SEG <sub>35</sub>	1197.68	-1830.4	A	219	SEG <sub>93</sub>	1197.68	1649.6	A
	SEG <sub>36</sub>	1197.68	–1770.4	A	220	SEG <sub>94</sub>	1197.68	1709.6	A
	SEG37	1197.68	–1710.4	A	221	SEG <sub>95</sub>	1197.68	1769.6	A
164	SEG <sub>38</sub>	1197.68	-1650.4	Α	222	SEG <sub>96</sub>	1197.68	1829.6	A
	SEG <sub>39</sub>	1197.68	-1590.4	Α	223	SEG <sub>97</sub>	1197.68	1889.6	Α
	SEG <sub>40</sub>	1197.68	-1530.4	А	224	SEG <sub>98</sub>	1197.68	1949.6	Α
167	SEG <sub>41</sub>	1197.68	-1470.4	Α	225	SEG <sub>99</sub>	1197.68	2009.6	Α
	SEG <sub>42</sub>	1197.68	-1410.4	Α	226	SEG100	1197.68	2069.6	Α
	SEG <sub>43</sub>	1197.68	-1350.4	Α	227	SEG101	1197.68	2129.6	Α
170	SEG44	1197.68	-1290.4	Α	228	SEG102	1197.68	2189.6	Α
171	SEG <sub>45</sub>	1197.68	-1230.4	A	229	SEG103	1197.68	2249.6	A
	SEG <sub>46</sub>	1197.68	-1170.4	A	230	SEG104	1197.68	2309.6	A
	SEG47	1197.68	-1110.4	A	230	SEG105	1197.68	2369.6	A
	SEG <sub>48</sub>	1197.68	-1050.4	A	231	SEG106	1197.68	2429.6	A

Table 2–1. Pad Layout (2/3)

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Table 2–1. Pad Layout (3/3)

Pad No.	Pad Name	Χ [μm]	Υ [ <i>μ</i> m]	Pad Type
233	SEG107	1197.68	2489.6	А
234	SEG108	1197.68	2549.6	Α
235	SEG109	1197.68	2609.6	Α
236	SEG110	1197.68	2669.6	Α
237	SEG111	1197.68	2729.6	Α
238	SEG112	1197.68	2789.6	Α
239	SEG113	1197.68	2849.6	A
240	SEG114	1197.68	2909.6	A
241	SEG115	1197.68	2969.6	A
242	SEG <sub>116</sub>	1197.68	3029.6	A
243	SEG117	1197.68	3089.6	A
243	SEG118	1197.68	3149.6	A
245	SEG119	1197.68	3209.6	A
245	SEG <sub>120</sub>	1197.68	3269.6	A
240	SEG120 SEG121			A
		1197.68	3329.6	
248	SEG122	1197.68	3389.6	A
249	SEG123	1197.68	3449.6	A
250	SEG <sub>124</sub>	1197.68	3509.6	A
251	SEG125	1197.68	3569.6	A
252	SEG <sub>126</sub>	1197.68	3629.6	Α
253	SEG <sub>127</sub>	1197.68	3689.6	A
254	SEG <sub>128</sub>	1197.68	3749.6	А
255	SEG <sub>129</sub>	1197.68	3809.6	Α
256	SEG130	1197.68	3869.6	Α
257	SEG131	1197.68	3929.6	Α
258	DUMMY6	1197.68	4022.2	С
259	DUMMY7	1032.44	4787.68	С
260	COM <sub>32</sub>	940	4787.68	A
261	COM <sub>33</sub>	880	4787.68	A
262	COM <sub>34</sub>	820	4787.68	A
263	COM <sub>35</sub>	760	4787.68	A
264	COM <sub>36</sub>	700	4787.68	A
265	COM <sub>37</sub>	640	4787.68	A
266	COM <sub>38</sub>	580	4787.68	A
267	COM38 COM39	520	4787.68	A
268		460	4787.68	A
269		400	4787.68	A
270	COM <sub>42</sub>	340	4787.68	A
271	COM <sub>43</sub>	280	4787.68	A
272	COM44	220	4787.68	A
273	COM <sub>45</sub>	160	4787.68	A
274	COM <sub>46</sub>	100	4787.68	A
275	COM <sub>47</sub>	40	4787.68	Α
276	COM <sub>48</sub>	-20	4787.68	Α
277	COM <sub>49</sub>	-80	4787.68	A
278	COM <sub>50</sub>	-140	4787.68	А
279	COM <sub>51</sub>	-200	4787.68	А
280	COM <sub>52</sub>	-260	4787.68	А
281	COM <sub>53</sub>	-320	4787.68	А
282	COM <sub>54</sub>	-380	4787.68	А
283	COM55	-440	4787.68	Α
284	COM <sub>56</sub>	-500	4787.68	Α
285	COM <sub>57</sub>	-560	4787.68	А
286	COM <sub>58</sub>	-620	4787.68	A
287	COM <sub>59</sub>	-680	4787.68	A
288		-740	4787.68	A
289	COM61	-800	4787.68	A
200	COM62	-860	4787.68	A
291	COM63	-920	4787.68	A
291		-920 -980	4787.68	A
232				
293	DUMMY8	-1072.6	4787.68	С

**Remark** Pad Type A: Pad size (Al): 47 x 105  $\mu$ m<sup>2</sup> (TYP.) Bump size: 35 x 92.5  $\mu$ m<sup>2</sup> (TYP.) Bump height: 17  $\mu$ m (TYP.) Pad Type B:

Pad size (AI): 75 x 105  $\mu$ m<sup>2</sup> (TYP.)

Bump size: 67 x 92.5  $\mu$ m<sup>2</sup> (TYP.) Bump height: 17  $\mu$ m (TYP.)

Pad Type C:

Pad size (Al): 118 x 105  $\mu$ m<sup>2</sup> (TYP.) Bump size: 110 x 92.5  $\mu$ m<sup>2</sup> (TYP.) Bump height: 17  $\mu$ m (TYP.)

# 3. PIN FUNCTIONS

# 3.1 Power Supply System Pins

Pin Symbol	Pin Name	Pad No.	I/O	Description
Vdd	Logic power supply pins	25 to 27	_	Power supply pins for logic. Apply the logic power supply voltage from an external source.
Vdd2	Booster circuit power supply pins	28 to 31	—	Power supply pins for booster circuit. Apply the booster circuit power supply voltage from an external source.
Vss	Logic/driver ground pins	32 to 37	—	Ground pins for logic and driver circuit. Connect these pins to an external ground.
Vlcd	Driver power supply pins	38 to 40	—	Power supply pins for driver. Output pins for internal booster circuit.
				Connect a 1- $\mu$ F capacitor for boosting between these pins and the GND pins.
				If not using the internal booster circuit, a direct driver power supply can be input.
Vdd'	Power supply pins for fixed mode pins	10,16,53,54, 78,84,88	_	These power supply pins are used to set the mode pins as fixed.
Vss'	Ground pins for fixed mode pins	7,13,57,58, 71,72,81,86	_	These ground pins are used to set the mode pins as fixed.
VLC1 to VLC5	Reference power supply pins for driver	59 to 68	_	These are reference power supply pins for the LCD driver. Connect a smoothing capacitor if an internal bias has been selected.
$C_1^+, C_1^-$ $C_2^+, C_2^-$ $C_3^+, C_3^-$	Capacitor connection pins	41 to 52	—	These are capacitor connection pins for the booster circuit. Connect a 1- $\mu$ F capacitor.

# 3.2 Logic System Pins (1/3)

Pin Symbol	Pin Name	Pad No.	I/O	Description
P,/S	Select data input	83	Input	This pin is used to select between parallel data input and serial data input. P,/S = H : Parallel data input P,/S = L : Serial data input This setting cannot be switched after power-on. For details, see <b>5. DESCRIPTION OF FUNCTIONS</b> .
/CS1,CS2	Chip select	8,9	Input	These pins are used for the chip select signal. When /CS1 = L and CS2 = H, this signal is active and can be used for I/O of data and commands.
/RD(E)	Read (enable)	15	Input	<ul> <li>When connected to 80 series CPU : active low This pin connects the 80 series CPU's RD signal. Data bus output status is set when this signal is low.</li> <li>When connected to 68 series CPU : active high It is used as the enable clock input pin for the 68 series CPU.</li> </ul>
/WR(R,/W)	Write (read/write)	14	Input	<ul> <li>When connected to 80 series CPU: active low This pin connects the 80 series CPU's /WR signal. Signals on the data bus are latched at the rising edge of the /WR signal.</li> <li>When connected to 68 series CPU This pin is an input pin for read/write control signals. R,/W = H : Read R,/W = L : Write</li> </ul>
C86	Interface select	82	Input	This pin is used to select the CPU interface. C86 = H : 68 series CPU interface C86 = L : 80 series CPU interface
D₀ to D₅	Data bus	17 to 22	Input /Output	When used with a parallel interface, these pins correspond to data bus bits D₀ to D₅. When used with a serial interface, they are pulled down internally.
D6 (SCL)	Data bus/serial clock	23	Input /Output	When used with a parallel interface, this pin corresponds to data bus bit $D_6$ . When used with a serial interface, it is a serial clock input pin.
D7 (SI)	Data bus/serial data input	24	Input /Output	When used with a parallel interface, this pin corresponds to data bus bit D7. When used with a serial interface, it is a serial data input pin.
AO	Data command	12	Input	<ul> <li>This pin is connected to the LSB in the ordinary CPU address bus to distinguish between data and commands.</li> <li>A0 = H : Indicates that display data exists in bits D<sub>0</sub> to D<sub>7</sub>.</li> <li>A0 = L : Indicates that display control commands exist in bits D<sub>0</sub> to D<sub>7</sub>.</li> </ul>
TESTOUT	Test output	6	Output	This pin is used as a test output. Leave this pin open when used for this purpose.
/RESET	Reset	11	Input	This pin is used to perform an internal reset when at low level.
CLS	Clock select	80	Input	This pin is used to select the valid/invalid setting for the display clock's on-chip oscillation circuit. CLS = H : On-chip oscillation circuit is valid CLS = L : On-chip oscillation circuit is invalid (external input) When CLS = L, a display clock is input via the CL pin.

# 3.2 Logic System Pins (2/3)

Pin Symbol	Pin Name	Pad No.	I/O	Description										
FR	Frame signal	3	Input /Output	signal.					D's AC c					
				This pin is used (along with the FRS pin) for the static drive.							/e.			
FRS	Static signal	2	Output											
M,/S	Master/Slave	79	Input	This pin is used (along with the FR pin) for the static drive.										
111,70	Waster/Olave	15	mpat	Input This pin is used to select master or slave operation mode. Timing signals required for the LCD are output during master										
						•	ng slave	mode t	o ensure	synchro	nization			
					CD block		e							
						ter opera e operati								
									atus of th	ne M./S a	and			
				CLS pin	-	,				,				
				M,/S	CLS	Oscillation	Power	CL	FR	FRS	/DOF			
						Circuit	supply							
							circuit							
				Н	Н	Valid	Valid	Output	Output	Output	Output			
					L	Invalid	Valid	Input	Output	Output	Output			
				L	Н	Invalid	Invalid	Input	Input	Hi-Z	Input			
					L	Invalid	Invalid	Input	Input	Hi-Z	Input			
CL	Display clock input 4 Input This pin is used as the display clock I/O /Output below, based on the status of the M,/S a								tings					
			/Output	Delow, L		M,/S		LS						
										-				
						Н		H L	Output	-				
						L		L H	Input	-				
						L		L	Input	-				
				When	aina thia				Input		a tha			
					onding C		laster or	slaven	node, cor	mect it to	June			
/DOF	Blink control	5	Input	· ·		to contro	ol blinkir	ng in the	LCD.					
			/Output	M,/S =	H : Out	put								
				M,/S =	L : Inpu	t								
					-			slave n	node, cor	nnect it to	o the			
НРМ	Power supply circuit select	85	Input			DOF pin.		rol nin c	of the pow	er sunn	v circuit			
	pin for LCD driver	00	mput	-	.CD driv					ici suppi	y on our			
				HPM =	H : Nor	mal mod	le							
				HPM =	L : Higł	n-power	mode							
IRS	Select pin for VLC1	87	Input	-		to selec	t the res	istor tha	t is used	to regula	ate the			
	regulating resistor			VLC1 vol	-	ct on-chi	n recietr	)r						
									. The V∟	c1 voltad	e is			
									an extern					
					resis									
									lected or					
				a hard reset or via a reset command. Instead, use this pin to										
				a hard r		/ia a rese								

# 3.2 Logic System Pins (3/3)

	Pin Symbol	Pin Name	Pad No.	I/O		Description						
*	TCS1,TCS2	Temperature gradient select	73,74	Input	No	These pins are used to select temperature gradient. Note the temperature gradient below, based on the status of the TCS1, TCS2.						
					TCS2 TCS1 Temperature gradient (% / °C)							
						L	L	-0.09				
						L	Н	0				
						н	L	-0.05				
						Н	Н	-0.14				
	TEST3	Test pins	75	Input	These are test pins for IC tests. Normally, these pins should be left open.							
	TEST4,TEST5	Test pins	76,77	Output	These are test pins for IC tests. Normally, these pins should be left open.							

# 3.3 Driver System Pins

Pin Symbol	Pin Name	Pad No.	I/O	Description
SEG <sub>0</sub> to SEG <sub>131</sub>	Segment	126 to 257	Output	Segment output pins
COM <sub>0</sub> to COM <sub>63</sub>	Common	91 to 122, 260 to 291	Output	Common output pins
COMS	Indicator common	123,292	Output	Common output pins for indicator The same signal is output from pin 2.
Vrs	Op amp inputs	55,56	Input	These are input pins for the op amp that regulates the LCD driver voltage. Leave the V <sub>RS</sub> pin open when using the on-chip power supply.
VR		69,70		When not using the on-chip power supply, a reference voltage $V_{REG}$ must be input. When using an external power supply, connect the V <sub>R</sub> pin to a
DUMMY1 to DUMMY8	Dummy pins	1,89,90,124,125, 258,259,293		resistor used to regulate the LCD voltage. Since these pins are not connected to any internal circuits, they should be left open when they are not being used.

# 4. PIN I/O CIRCUITS AND RECOMMENDED CONNECTION OF UNUSED PINS

The input/output circuit type of each pin and recommended connection of unused pins are shown in the following table.

Pin Name	I/O	Recommended Connection of Unused Pins	Notes
P,/S	Input	Mode setting pin	1
/CS1	Input	Connect to Vss	
CS2	Input	Connect to VDD	
/RD(E)	Input	Connect to V <sub>DD</sub> (80 series interface),	
		connect to VDD or Vss (serial interface)	
/WR (R,/W)	Input	Connect to VDD or VSS (serial interface)	
C86	Input	Mode setting pin	1
D₀ to D₅	Input/Output	Leave open (when using serial interface)	2
D <sub>6</sub> (SCL)	Input/Output		
D7 (SI)	Input/Output		
A0	Input	Data/command setting pin	3
TESTOUT	Output	Leave open	
/RESET	Input	Connect to VDD	
CLS	Input	Mode setting pin	1
FR	Input/Output	Leave open (when using master mode, M,/S = H)	
FRS	Output	Leave open	
/DOF	Input/Output	Leave open (when using master mode, M,/S = H)	
M,/S	Input	Mode setting pin	1
CL	Input/Output	Display clock	4
НРМ	Input	Mode setting pin	1
IRS	Input	Mode setting pin	1
TCS1	Input	Mode setting pin	1
TCS2	Input	Mode setting pin	1
TEST3	Input	Leave open	2
TEST4	Output	Leave open	
TEST5	Output	Leave open	

**Notes 1.** Connect to VDD or Vss according to the selected mode.

2. These pins are pulled down to Vss in the IC.

3. Input CPU output from  $V_{\text{DD}}$  or  $V_{\text{SS}}$  according to the selected register.

4. This pin is an output when M/S = H and CLS = H but should otherwise be used to input the display clock.

# 5. DESCRIPTION OF FUNCTIONS

#### 5.1 CPU Interface

#### 5.1.1 Select interface type

The  $\mu$  PD16682A transfers data either via an 8-bit bidirectional data bus (D<sub>7</sub> to D<sub>0</sub>) or via a serial data input (SI). The P,/S pin can be set to either high or low levels to select 8-bit parallel data input or serial data input, as shown in the table below.

P,/S	/CS1	CS2	A0	/RD	/WR	C86	D7	D6	D5 - D0
H: Parallel input	/CS1	CS2	A0	/RD	/WR	C86	D7	D <sub>6</sub>	D5 -D0
L: Serial input	/CS1	CS2	A0	Note 1	Note 1	Note1	SI	SCL	Note2

**Notes 1.** Fix this pin as either H or L.

2. High impedance

#### 5.1.2 Parallel interface

If the parallel interface has been selected (P,/S = H), setting the C86 pin either high or low determines whether to connect directly to the 80 series CPU or the 68 series CPU, as shown in the table below.

P,/S	/CS1	CS2	A0	/RD	D7 - D0
H: 68 series CPU bus	/CS1	CS2	A0	E	D7 - D0
L: 80 series CPU bus	/CS1	CS2	A0	/RD	D7 - D0

The data bus signal can be identified according to the combination of A0, /RD(E), and /WR (R,/W) signals, as shown in the table below.

Common	68 Series	80 Series		Function
A0	R,/W	/RD	/WR	
н	Н	L	Н	Read display data
н	L	Н	L	Write display data
L	Н	L	Н	Read status
L	L	Н	L	Write control data (command)

# (1) 80 Series Parallel Interface

When 80 series parallel data transfer has been selected, data is written to the  $\mu$  PD16682A at the rising edge of the /WR signal. The data is output to the data bus when the /RD signal is L.

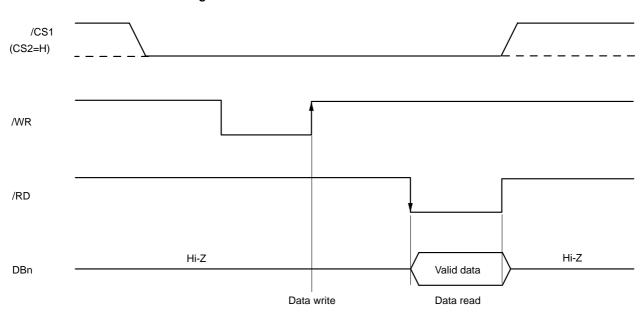
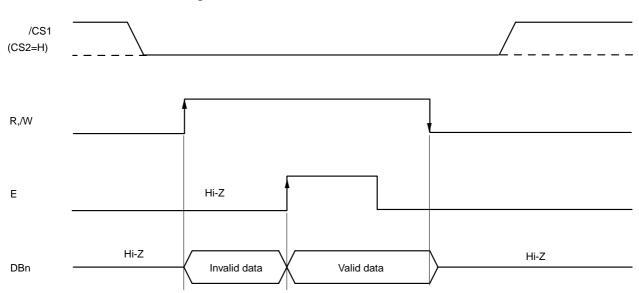


Figure 5–1 80 Series Interface Data Bus Status

# (2) 68 Series Parallel Interface

When 68 series parallel data transfer has been selected, data is written at the falling edge of the E signal when the R,/W signal is L. During the data read operation, the data bus enters the output status when the R,/W signal is H, outputs valid data at the rising edge of the E signal, and enters the high-impedance state at the falling edge of the R,/W signal (R,/W = L)





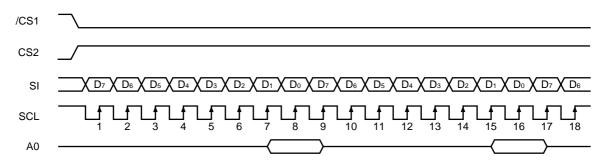
#### 5.1.3 Serial interface

If the serial interface has been selected (P,/S = L) and if the chip is in the active state (/CS1 = L and CS2 = H), both serial data input (SI) and serial clock input (SCL) can be received. The serial interface includes an 8-bit shift register and a 3-bit counter. Serial data is captured at the rising edge of the serial clock and is clocked in via the serial data input pins in sequence from  $D_7$  to  $D_0$ . At the rising edge of the eighth serial clock, data is converted to 8-bit parallel data.

Input via the A0 pin can be used to determine whether the input serial data is display data or a command (display data when A0 = H, command when A0 = L). The timing for reading and identifying input via A0 occurs at the rising edge of the "eighth x n" serial clock once the chip's status is active.

A serial interface signal chart is shown below.

Figure 5–3. Serial Interface chart



**Remarks 1.** When the chip's status is inactive, the shift register and counter are both reset to their initial values.

2. Data cannot be read when using the serial interface.

**3.** For the SCL signal, caution is advised concerning the wire's terminating reflection and noise from external sources. We recommend to check the operation on the actual equipment.

#### 5.1.4 Chip select

The  $\mu$  PD16682A has two chip select pins (/CS1 and CS2). The CPU interface or serial interface can be used only when /CS1 = L and CS2 = H.

When the chip select pin is inactive,  $D_7$  to  $D_0$  are set to high impedance (invalid) and input of A0, /RD, or /WR is invalid. If the serial interface has been selected, the shift register and counter are both reset.

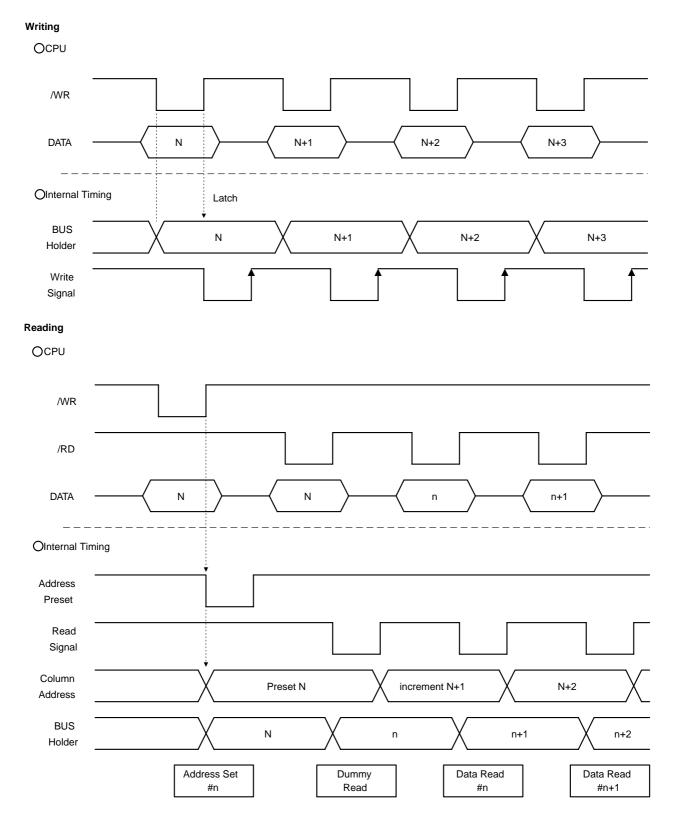
#### 5.1.5 Display data RAM and internal register access

Access to the  $\mu$  PD16682A from the CPU supports high-speed data transfers since the cycle time (tcyc) is met and there is no need for wait time.

When data transfer occurs between the  $\mu$  PD16682A and the CPU, the data is held in a bus holder belonging to the internal data bus and is written to the display data RAM before the next data write cycle. When the CPU reads the contents of the display data RAM, the data read during the first data read cycle (dummy cycle) is first held in the bus holder and is read from the bus holder to the system bus during the next data read cycle.

Note with caution that, due to constraints on the read sequence for the display data RAM, when the address is set, the data is not output from the address specified by the next read command but rather is output to the address specified during the second data read operation. Consequently, one dummy read operation is strictly required after setting an address or after a write cycle. Figure 5–4 illustrates this situation.





# 6. DISPLAY DATA RAM

#### 6.1 Display Data RAM

This is the RAM that is used to store the display's dot data. The RAM configuration is 65 (8 pages x 8 bits + 1) x 132 bits. Any specified bit can be accessed by selecting the corresponding page address and column address.

As is shown in Figure 6–1 below, the display data ( $D_7$  to  $D_0$ ) from the CPU corresponds to the common direction in the LCD, so that if a multiple set of  $\mu$  PD16682A chips is used, there are fewer constraints on transfers of display data and relatively more freedom for display configurations.

The CPU accesses the display data RAM for read/write operations via the I/O buffer, and these operations are independent of the LCD driver signal read operations. Therefore, there are absolutely no adverse effects (such as flicker) in the display when display data RAM is accessed asynchronously in relation to the LCD contents.

		L	CD da	ata		
D <sub>0</sub>	0	1	1	1	0	
D1	1	0	0	0	0	
D2	0	0	0	0	0	
Dз	0	1	1	1	0	
D4	1	0	0	0	0	

Figure 6–1.	LCD Data and	LCD Display
-------------	--------------	-------------

	LCD display							
COM <sub>0</sub>								
COM <sub>1</sub>								
COM <sub>2</sub>								
COM <sub>3</sub>								
COM <sub>4</sub>								

I CD diamlay

#### 6.2 Page Address Circuit

The page address set command specifies the page address in the display data RAM, as is shown in Figure 6–2. To access a different page, simply specify a different page address using this command.

Page address 8 ( $D_3$ , $D_2$ , $D_1$ , $D_0$  = 1,0,0,0) is a RAM area that is used exclusively for indicator, so only display data  $D_0$  is valid.

#### 6.3 Column Address Circuit

The column address set command specifies the column address in the display data RAM, as is shown in Figure 6–2. The specified column address is incremented each time a display data read or write command is input, so the CPU is able to successively access display data.

Incrementation of the column address stops at 83H. The column address and page address are mutually independent, which means that to switch from column 83H on page 0 to column 00H on page 1, both the page address and column address must be separately specified again.

Also, as is shown in Table 6–1, the ADC command (segment driver direction select command) can be used to invert the correspondence between the display data RAM's column address and segment output. This reduces the number of IC layout constraints that are imposed when setting up the LCD module.

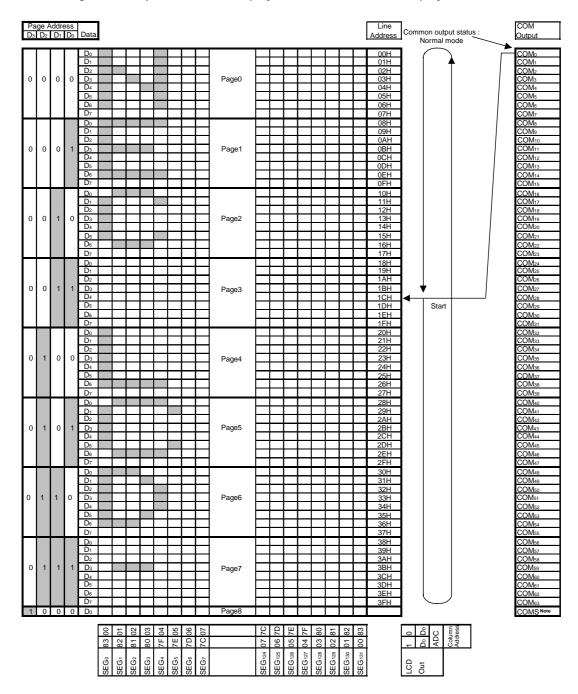
Table 6–1. Relation between Display Data RAM Column Address and Segment Output

SEG Ou	ıtput	SEG₀				SEG131
ADC	"0"	00H	$\rightarrow$	Column Address	$\rightarrow$	83H
(D <sub>0</sub> )	"1"	83H	$\downarrow$	Column Address	$\leftarrow$	00H

# 6.4 Line Address Circuit

As is shown in Figure 6–2, the line address circuit specifies the line address that corresponds to a COM output for displaying the contents of display data RAM. The display start line address set command usually specifies the highest line in the display (corresponding to the COM<sub>0</sub> output when in normal mode or the COM<sub>63</sub> output when in inverted mode). Thus, there are 65 lines in the direction of incrementation of line address starting from the specified display start line address.

The screen can be scrolled by dynamically changing the line address via the display start line address set command.





Note COMS accesses the 65th line regardless of the display start line address.

#### 6.5 Display Data Latch Circuit

The display data latch circuit is used for temporary storage of display data that has been output to the LCD driver circuit from the display data RAM.

The commands that are used to set normal/inverted display modes, display ON/OFF status, and display all ON/OFF status are commands that control data in this latch so that there is no modification of the data in the display data RAM.

# 7. OSCILLATION CIRCUIT

This is a CR-type oscillation circuit that generates the display clock. The oscillation circuit is valid only when CLS = H. When CLS = L, oscillation is stopped and the display clock is input via the CL pin.

# 8. DISPLAY TIMING GENERATOR

The display timing generator generates timing signals from the display clock to the line address circuit and the display data latch circuit. Display data is latched into the display data latch circuit in synch with the display clock and is output via segment driver output pins. Reading of the display data is completely independent of the CPU's accessing of the display data RAM. Consequently, there are no adverse effects (such as flicker) on the LCD panel even when the display data RAM is accessed asynchronously in relation to the LCD contents.

The internal common timing and LCD's AC conversion signal (FR) are both generated from the display clock. As is shown in Figure 8–1, a drive waveform based on the two-frame AC drive method is generated for the LCD driver circuit.

If a multiple set of  $\mu$ PD16682A chips is used, the display timing signals (FR, CL, and /DOF) for the slave side must be supplied from the master side.

	FR	CL	/DOF	
Master (M,/S = H)	On-chip oscillation circuit is valid (CLS = H)	Output	Output	Output
	On-chip oscillation circuit is invalid (CLS = L)	Output	Input	Output
Slave (M,/S = L)	On-chip oscillation circuit is invalid (CLS = H)	Input	Input	Input
	On-chip oscillation circuit is invalid (CLS = L)	Input	Input	Input

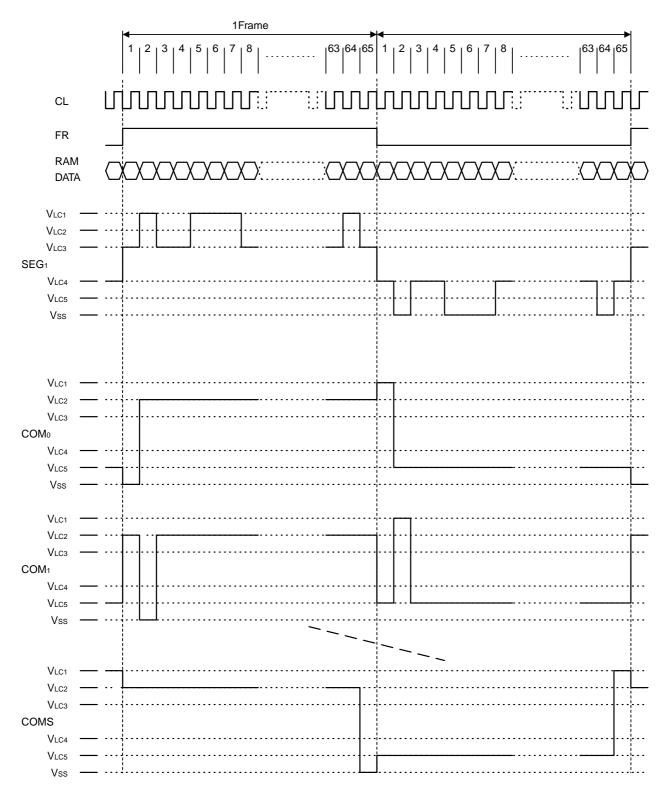


Figure 8–1. Drive Waveform when Using Two-Frame AC Drive Method

# 9. COMMON OUTPUT STATUS SELECT CIRCUIT

With the  $\mu$  PD16682A, the common output status select command can be used to set the scan direction for COM outputs (see **Table 9–1**). As a result, there are fewer IC layout constraints when setting up the LCD module.

Status	CC	OM Scan Direc	tion
Normal (forward)		$\rightarrow$	COM <sub>63</sub>
Inverted (reverse)	COM63	$\rightarrow$	COMo

Table 9–1. Setting of Scan Direction for COM Outputs

# **10. POWER SUPPLY CIRCUIT**

#### 10.1 Power Supply Circuit

The power supply circuit, which supplies the voltage needed to drive the LCD, includes a booster circuit, voltage regulator circuit, and voltage follower circuit.

The power control set command is used to control the ON/OFF status of the power supply circuit's booster circuit, voltage regulator circuit (V regulator circuit), and voltage follower circuit (V/F circuit). This makes it possible to jointly use an external power supply along with certain functions of the on-chip power supply. Table 10–1 shows the function that controls the 3-bit data in the power control set command and Table 10–2 shows a reference chart of combinations.

	Item	Status			
		н	L		
D2	Booster circuit control bit	ON	OFF		
D1	Voltage regulator circuit control bit	ON	OFF		
Do	Voltage follower circuit control bit	ON	OFF		

Use Status	D2	D1	Do	Booster Circuit	V Regulator Circuit	V/F Circuit	External Power Supply Input	Booster- related Pin
<1> Use on-chip power supply	Н	н	н	i	i	i	V <sub>DD2</sub>	Used
<2> Use V regulator circuit and V/F circuit only	L	Н	Н	×	i	ï	VLCD	Open
<3> Use V/F circuit only	L	L	н	×	×	i	VLC1	Open
<4> Use External power supply only	L	L	L	×	×	×	VLC1 to VLC5	Open

Table 10–2. Reference Chart of Combinations

**Remarks 1.** The booster-related pins are indicated as pins  $C_1^+$ ,  $C_1^-$ ,  $C_2^+$ ,  $C_2^-$ ,  $C_3^+$ , and  $C_3^-$ .

**2.** Although combinations other than those shown above are possible, they have no practical uses and therefore cannot be recommended.

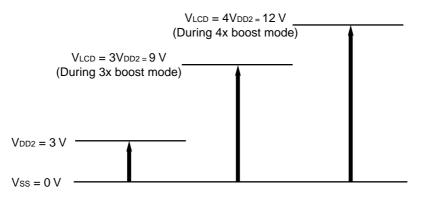
#### 10.2 Booster circuit

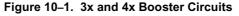
3x and 4x booster circuits have been incorporated in chip to generate the current driving the LCD.

When using the internal power supply, connect the booster-related capacitor between  $C_1^+$  and  $C_1^-$ ,  $C_2^+$  and  $C_2^-$ , and  $C_3^+$  and  $C_3^-$ . Also, connect the level stabilization-related capacitor between  $V_{LCD}$  and  $V_{SS}$  and set  $D_2$  high to boost the potential between  $V_{DD2}$  and  $V_{SS}$  from 3 to 4 times.

Since the booster circuit uses signals from the internal oscillation circuit, the oscillation circuit must be operating. The relation between the boosted voltage and the potential is described below.

The  $C_1^+$ ,  $C_1^-$ ,  $C_2^+$ ,  $C_2^-$ ,  $C_3^+$ ,  $C_3^-$ , and  $V_{DD2}$  pins all relate to the booster circuit, so the wire impedance should be minimized.





# Caution When set to 3x boost mode, connect booster-related capacitors between $C_2^-$ and $C_3^+$ and between $C_1^+$ and $C_1^-$ .

#### 10.3 Voltage Regulator Circuit

The boost voltage that was generated at V<sub>LCD</sub> is output via the voltage regulator circuit as the LCD drive voltage V<sub>LC1</sub>. Since the  $\mu$  PD16682A has a 64-level electronic volume function and an on-chip resistor for V<sub>LC1</sub> voltage regulation, various components can be used to configure a highly accurate voltage regulator circuit.

#### 10.3.1 Use of on-chip resistor for VLC1 voltage regulation

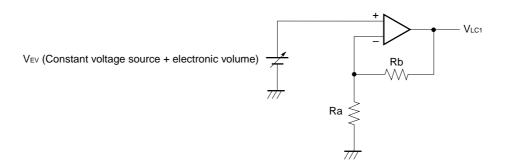
The on-chip resistor for V<sub>LC1</sub> voltage regulation and the electronic volume function can be used to regulate the darkness of the LCD contents, not only by adding an external resistor but also by controlling the LCD drive voltage V<sub>LC1</sub> by using commands only. The V<sub>LC1</sub> voltage can be determined using equation 10–1 as within the range of V<sub>LC1</sub> < V<sub>LCD</sub>.

#### Equation 10-1

$$V_{LC1} = (1 + \frac{Rb}{Ra})V_{EV}$$

The equation for determining VEV varies according to the temperature gradient.

$$V_{EV} = \frac{162}{202} (1 - \frac{\alpha}{162}) V_{REG} (-0.05\% / °C)$$
$$V_{EV} = \frac{162}{179} (1 - \frac{\alpha}{162}) V_{REG} (-0.09\% / °C)$$
$$V_{EV} = (1 - \frac{\alpha}{162}) V_{REG} (-0.14\% / °C)$$
$$V_{EV} = \frac{162}{232} (1 - \frac{\alpha}{162}) V_{REG} (0\% / °C)$$



 $V_{REG}$  is the IC's internal constant voltage source, whose voltage values (at  $T_A = 25^{\circ}C$ ) are listed in Table 10–3 below.

\*

Table	10–3.	VREG

TCS2	TCS1	Temperature Gradient (%/°C)	Vreg (V)
L	L	-0.09	1.87
L	Н	0	2.41
Н	L	-0.05	2.10
Н	Н	-0.14	1.69

Given  $\alpha$  as the electronic volume command value, when data is set to the 6-bit electronic volume register, one of 64 statuses is set. Values for  $\alpha$  corresponding to various electronic volume register settings are listed in Table 10–4 below.

D5	D4	D3	D <sub>2</sub>	D1	Do	α
0	0	0	0	0	0	63
0	0	0	0	0	1	62
0	0	0	0	1	1	61
0	0	0	0	1	1	60
:	:	••	••	•••	••	••
1	1	1	1	0	1	2
1	1	1	1	1	0	1
1	1	1	1	1	1	0

Rb/Ra is an on-chip resistance factor used for the VLc1 voltage regulator. This factor can be controlled among eight levels using the VLc1 voltage regulator resistance factor set command. Table 10–5 lists reference values for (1+Rb/Ra) which are set when 3-bit data is set to the VLc1 voltage regulator resistance factor register.

	Register		Reference Value
D3	D2	D1	
0	0	0	3.5
0	0	1	4.0
0	1	0	4.5
0	1	1	5.0
1	0	0	5.5
1	0	1	6.0
1	1	0	6.5
1	1	1	7.0

Table 10–5. Reference Values for (1 + Rb/Ra)

#### 10.3.2 When using external resistor (not using on-chip resistor for VLc1 voltage regulator)

Instead of using the on-chip resistor for the V<sub>LC1</sub> voltage regulator (IRS pin = L), resistors (Ra' and Rb') can be added between V<sub>SS</sub> and V<sub>R</sub> and between V<sub>R</sub> and V<sub>LC1</sub> to set the LCD power supply voltage V<sub>LC1</sub>. In such cases, the electronic volume function can be used to control the LCD power supply voltage V<sub>LC1</sub> using commands to regulate the darkness of the LCD contents. The V<sub>LC1</sub> voltage can be determined using equation 10–2 as within the range of  $V_{LC1} < V_{LCD}$ .

#### Equation 10-2

$$V_{\text{LC1}} = \big(1 + \frac{Rb'}{Ra'}\big) V_{\text{EV}}$$

\*

The equation for determining VEV varies according to the temperature gradient.

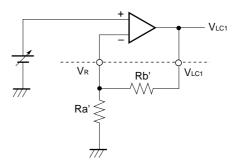
$$V_{EV} = \frac{162}{202} (1 - \frac{\alpha}{162}) V_{REG} (-0.05\% / °C)$$

$$V_{EV} = \frac{162}{179} (1 - \frac{\alpha}{162}) V_{REG} (-0.09\% / °C)$$

$$V_{EV} = (1 - \frac{\alpha}{162}) V_{REG} (-0.14\% / °C)$$

$$V_{EV} = \frac{162}{232} (1 - \frac{\alpha}{162}) V_{REG} (0\% / °C)$$

VEV (Constant voltage source + electronic volume)



#### 10.4 Op Amp Control for Level Power Supply

The  $\mu$ PD16682A's on-chip power supply circuit is designed for low power consumption (HPM = H). Consequently, display quality may be diminished when a large LCD device or panel is used. In such cases, the display quality can be improved by setting HPM = L (high-power mode). We recommend that you check the actual display quality before deciding whether or not to use high-power mode.

If setting high-power mode still does not sufficiently improve the display quality, the LCD driver's power supply must be provided from an external source.

# 10.5 Command Sequence for Stepping Down On-chip Power Supply

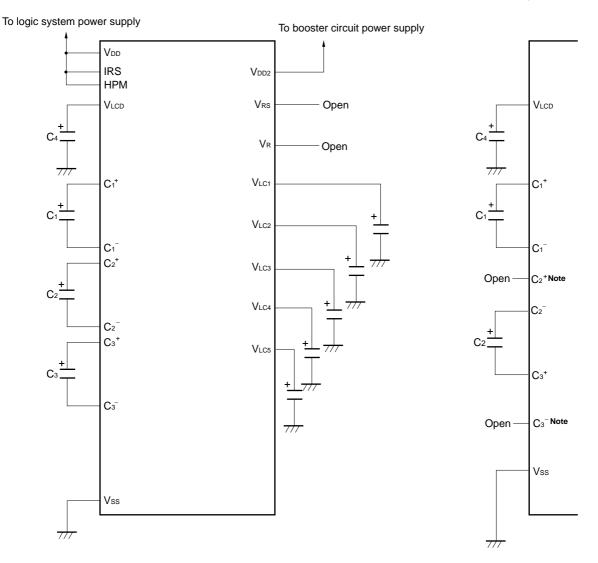
As shown in the following command sequence, we recommend that you set low power mode and turn off the power before stepping down the on-chip power supply.

	Step	Description			С	omman	d Addres	SS			
		(Command, Status)	D7	D <sub>6</sub>	D₅	D4	D₃	D2	D1	Do	
	Step1	Display OFF	1	0	1	0	1	1	1	0	Power save command
	Step2	Display all ON	1	0	1	0	0	1	0	1	(compound)
	End	On-chip power supply									
▼		OFF									J

# 10.6 Use Example of Power Supply Circuit

A) 4x boost (normal mode/using on-chip power supply)

B) 3x boost



**Note** Leave the  $C_2^+$  and  $C_3^-$  pins open. **Remark**  $C_1 = C_2 = C_3 = C_4 = 1.0 \ \mu\text{F}$ 

# **11. RESET CIRCUIT**

In the  $\mu$  PD16682A, when the /RESET input is at low level, a reset is executed. The reset (default) settings are described below.

- 1. Display OFF
- 2. Normal display direction
- 3. ADC select: normal direction (ADC command Do =L)
- 4. Power control register:  $(D_2, D_1, D_0) = (0, 0, 0)$
- 5. Data cleared from register in serial interface
- 6. LCD power supply bias: 1/9 bias
- 7. Read modify write OFF
- 8. Power save canceled
- 9. SEG/COM output: Vss
- 10. Static indicator OFF

Static indicator register:  $(D_2,D_1) = (0,0)$ 

- 11. Display start line: set to line 1
- 12. Column address: set to address 0
- 13. Page address: set to page 0
- 14. Common output status: Normal
- 15. Canceled mode set for on-chip resistance factor for V<sub>LC1</sub> voltage regulator V<sub>LC1</sub> voltage regulator resistance factor register (D<sub>2</sub>,D<sub>1</sub>,D<sub>0</sub>) = (0,0,0)
- 16. Canceled mode set for electronic volume register

Electronic volume register:  $(D_5, D_4, D_3, D_2, D_1, D_0) = (1, 0, 0, 0, 0, 0)$ 

- 17. Test mode canceled
- 18. Display all OFF (display all ON/OFF command, D<sub>0</sub> = L)

Only items 1, 7, and 9 to 18 above are executed when a reset command is used.

#### 12. COMMANDS

The  $\mu$  PD16682A uses a combination of A0, /RD(E), and /WR(R,/W) to identify data bus signals. Command interpretation and execution is performed using internal timing that does not depend on any external clock.

The 80 series CPU interface activates commands using low pulse input to the /RD pin during read and activates commands using low pulse input to the /WR pin during write. The 68 series CPU interface sets read mode using high-level input to the R,/W pin and sets write mode using low-level input to the R,/W pin. The command is activated using high pulse input to the E pin.

Thus, the 68 series CPU interface differs from the 80 series CPU interface in that /RD(E) is at high level during status read and display data read operations, as is shown in the command descriptions and command table. Command descriptions using an 80 series CPU interface are shown below.

If the serial interface has been selected, data is input sequentially starting from D7.

#### 12.1 Display ON/OFF

This command specifies the display's ON/OFF status.

A0	E,/RD	R,/W, /WR	D7	D <sub>6</sub>	D₅	D4	D₃	D <sub>2</sub>	D1	Do	Setting
0	1	0	1	0	1	0	1	1	1	1	Display ON
										0	Display OFF

Executing the display all ON command while the display is OFF sets power save (low power) mode. For details, see **12.20 Power Save (Compound Command)**.

When the display is OFF, output via all driver outputs (segment and common) is at Vss level.

#### 12.2 Display Start Line Set

This command specifies the address of the display start line in the display data RAM, as was shown in Figure 6–2. The display area extends from the specified line address in the direction of higher line addresses, and includes the number of lines that corresponds to the display duty setting. The display can be smoothly scrolled vertically by using this command to dynamically modify the specified line addresses.

For details, see 6.4 Line Address Circuit.

A0	E, /RD	R,/W, /WR	D7	D6	D₅	D4	D₃	D2	D1	Do	Line Address
0	1	0	0	1	0	0	0	0	0	0	0
					0	0	0	0	0	1	1
					0	0	0	0	1	0	2
							$\rightarrow$				$\downarrow$
					1	1	1	1	1	0	62
					1	1	1	1	1	1	63

#### 12.3 Page Address Set

This command specifies the page address corresponding to the row address when accessing the display data RAM from the CPU side, as was shown in Figure 6–2. The specified bit in display data RAM can be accessed by selecting the corresponding page address and column address. If the page address is changed, the display mode does not change.

For details, see 6.2 Page Address Circuit.

A0	E, /RD	R,/W, /WR	D7	D6	D₅	D4	D₃	D2	D1	D٥	Page Address
0	1	0	1	0	1	1	0	0	0	0	0
							0	0	0	1	1
							0	0	1	0	2
									$\rightarrow$		$\downarrow$
							0	1	1	1	7
							1	0	0	0	8

#### 12.4 Column Address Set

This command specifies the column address in display data RAM, as was shown in Figure 6–2. The column address is set in a (basically continuous) series of two specifications, one for the high-order four bits and another for the low-order four bits. The column address is automatically incremented (+1) each time the display data RAM is accessed, so the CPU is able to continuously read or write display data. Incrementation of the column address stops at 83H. At that point the page address can no longer be continuously modified. For details, see **6.3 Column Address Circuit**.

A0	E, /RD	R,/W, /WR	D7	D6	D₅	D4	D₃	D2	D1	Do
0	1	0	0	0	0	1	A7	A6	A5	A4
						0	A3	A2	A1	A0

A7	A6	A5	A4	A3	A2	A1	A0	Column Address
0	0	0	0	0	0	0	0	0
0	0	0	0	0	0	0	1	1
0	0	0	0	0	0	1	0	2
				$\downarrow$				$\rightarrow$
1	0	0	0	0	0	1	0	130
1	0	0	0	0	0	1	1	131

#### 12.5 Status Read

A0	E, /RD	R,/W, /WR	D7	D <sub>6</sub>	D₅	D4	D3	D2	D1	Do
0	0	1	0	ADC	ON/OFF	RESET	0	0	0	0

ADC	This indicates the relation between the column address and the segment driver. 0: Inverted (column address 131-n $\leftrightarrow$ $\rightarrow$ SEGn)
	1: Normal (column address n←→SEGn)
ON/OFF	ON/OFF: Indicates the display's ON/OFF status.
	0: Display ON
	1: Display OFF
	(This is the opposite of the display ON/OFF command's polarity.)
RESET	This indicates whether or not the system is undergoing a reset via the /RESET
	signal or the reset command.
	0: Operating mode
	1: Reset in progress

#### 12.6 Display Data Write

This command writes 8 bits of data to the specified address in display data RAM. After this data has been written, the column address is automatically incremented (+1), which enables the CPU to continuously write display data.

A0	E, /RD	R,/W, /WR	D7	D <sub>6</sub>	D₅	D4	Dз	D2	D1	Do
1	1	0				Write	Data			

#### 12.7 Display Data Read

This command reads 8 bits of data from the specified address in display data RAM. After this data has been read, the column address is automatically incremented (+1), which enables the CPU to continuously read several words of data.

A single dummy read operation is required immediately after the column address has been set. For details, see **5.1.5 Display data RAM and internal register access**.

Note that the display data cannot be read when using a serial interface.

A0	E, /RD	R,/W, /WR	D7	D <sub>6</sub>	D5	D4	D3	D2	D1	Do
1	0	1				Read	Data			

#### 12.8 ADC Select (Segment Driver Direction Select)

This command inverts the relation between the display data RAM's column address and segment driver output, as was shown in Figure 6–2. Consequently, the segment driver output pin number can be inverted by this command. For details, see **6.3 Column Address Circuit**. Incrementation (+1) of the column address when display data is either written or read is performed according to the column address shown in Figure 6–2.

This command should be input during initialization.

A0	E, /RD	R,/W, /WR	D7	D <sub>6</sub>	D₅	D4	D3	D2	D1	Do	Setting
0	1	0	1	0	1	1	0	0	0	0	Normal (forward direction)
										1	Inverted (reverse direction)

#### 12.9 Display Normal/Inverted

This command can be used to invert the display ON/OFF control without replacing any of the display data RAM contents. The display data RAM contents are retained when this command is executed.

A0	E, /RD	R,/W, /WR	D7	D <sub>6</sub>	D₅	D4	D3	D <sub>2</sub>	D1	Do	Setting
0	1	0	1	0	1	0	0	1	1	0	RAM data: H
											LCD ON potential (normal)
										1	RAM data: L
											LCD ON potential (inverted)

#### 12.10 Display All ON/OFF

This command can be used to set the display all ON status forcibly regardless of the display data RAM contents. The display data RAM contents are retained when this command is executed.

This command takes priority over the display normal/inverted command.

A0	E, /RD	R,/W, /WR	D7	D <sub>6</sub>	D₅	D4	D3	D <sub>2</sub>	D1	Do	Setting
0	1	0	1	0	1	0	0	1	0	0	Normal display mode
										1	Display all ON

# 12.11 LCD Bias Set

This command selects the bias setting of the voltage required to drive the LCD. This command is valid when the power supply circuit's V/F circuit is operating.

A0	E, /RD	R,/W, /WR	D7	D <sub>6</sub>	D₅	D4	Dз	D <sub>2</sub>	D1	Do	Setting
0	1	0	1	0	1	0	0	0	1	0	1/9 bias
										1	1/7 bias

#### 12.12 Read Modify Write

This command is used in a pair with the end command. When this command has been input, the column address is not changed by the display data read command and can be incremented (+1) only by the display data write command. This status is retained until an end command is input. Once an end command has been input, the column address returns to the address that was used when the read modify write command was input. This function can be used to lighten the burden on the CPU when repeatedly modifying data in special display areas such as the blinking cursor.

A0	E, /RD	R,/W, /WR	D7	D <sub>6</sub>	D₅	D4	Dз	D2	D1	Do
0	1	0	1	1	1	0	0	0	0	0

Caution The commands other than the display data read/write commands can be used even during read modify write mode. However, the column address set command cannot be used.

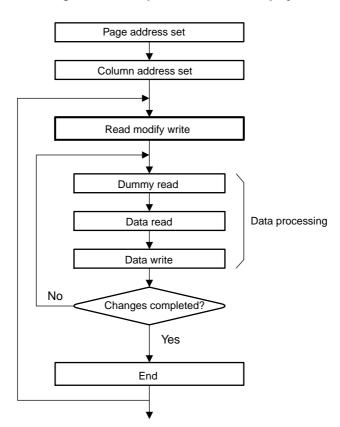


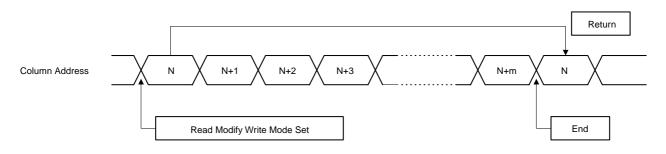
Figure 12–1. Sequence for Cursor Display

#### 12.13 End

This command is used to cancel read modify write mode and return to the address that was used during column address mode reset.

A0	E, /RD	R,/W, /WR	D7	D <sub>6</sub>	D₅	D4	Dз	D2	D1	Do
0	1	0	1	1	1	0	1	1	1	0

#### Figure 12–2. End



# 12.14 Reset

This command initializes the contents of the various command registers. The display data RAM is not affected. For details, see **11. RESET CIRCUIT**.

The reset operation is performed after the reset command has been input.

A0	E, /RD	R,/W, /WR	D7	D6	D₅	D4	D3	D <sub>2</sub>	D1	D <sub>0</sub>
0	1	0	1	1	1	0	0	0	1	0

The reset that occurs when the power supply is applied is performed by issuing a reset signal to the /RESET pin. It cannot be used as a substitute for the reset command.

#### 12.15 Common Output Status Select

This command can be used to select the scan direction for the COM output pins. For details, see **9. COMMON OUTPUT STATUS SELECT CIRCUIT.** 

A0	E, /RD	R,/W, /WR	D7	D6	D₅	D4	Dз	D2	D1	Do	Setting
0	1	0	1	1	0	0	0	х	х	х	Normal (forward)
							1				Inverted (reverse)

Remark X: Don't care

Status		Selected statu	S
Normal (forward)	COMo	$\rightarrow$	COM <sub>63</sub>
Inverted (reverse)	COM <sub>63</sub>	$\rightarrow$	COMo

# 12.16 Power Control Set

This command is used to set the function of the power supply circuit. For further description, see **10. POWER SUPPLY CIRCUIT.** 

A0	E, /RD	R,/W, /WR	D7	D <sub>6</sub>	D₅	D4	D3	D2	D1	Do	Selected Status
0	1	0	0	0	1	0	1	0	х	х	Booster circuit: OFF
								1	х	х	Booster circuit: ON
								х	0	х	V regurator circuit: OFF
								х	1	х	V regurator circuit: ON
								х	х	0	V/F circuit: OFF
								х	х	1	V/F circuit: ON

Remark X: Don't care

#### 12.17 Set On-chip Resistance Factor for VLC1 Voltage Regulator

This command is used to set the on-chip resistance factor for the VLC1 voltage regulator. For details, see **10.3** Voltage Regulator Circuit.

A0	E, /RD	R,/W, /WR	D7	D <sub>6</sub>	D₅	D4	D3	D <sub>2</sub>	D1	Do	(1+Rb/Ra)
0	1	0	0	0	1	0	0	0	0	0	3.5
								0	0	1	4.0
								0	1	0	4.5
								0	1	1	5.0
								1	0	0	5.5
								1	0	1	6.0
								1	1	0	6.5
								1	1	1	7.0

# 12.18 Electronic Volume (Two-Byte Command)

This command can be used to control the LCD drive voltage V<sub>LC1</sub> (which is output from the on-chip LCD power supply's voltage regulator circuit) to regulate the darkness of the LCD contents.

This command is a two-byte command that is used in a pair with the electronic volume mode set command and the electronic volume register set command, so be sure to use both commands consecutively.

#### 12.18.1 Electronic volume mode set command (first byte)

Once this command is input, the electronic volume register set command becomes valid. And once the electronic volume mode has been set, any command other than the electronic volume register set command cannot be used. This restriction is cleared once data has been set to the register by the electronic volume register set command.

A0	E, /RD	R,/W, /WR	D7	D <sub>6</sub>	D₅	D4	Dз	D2	D1	Do
0	1	0	1	0	0	0	0	0	0	1

#### 12.18.2 Electronic volume register set command (second byte)

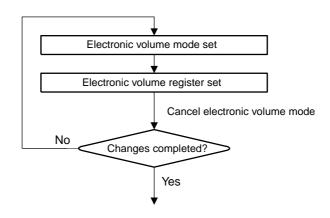
When six bits of data are set to the electronic volume register by this command, the LCD drive voltage V<sub>LC1</sub> is set to one of 64 possible voltage values.

Once this command has been input and the electronic volume register has been set, electronic volume mode is canceled.

A0	E, /RD	R,/W, /WR	D7	D6	D₅	D4	Dз	D2	D1	Do	VLC1
0	1	0	х	х	0	0	0	0	0	0	Smaller value
			Х	Х	0	0	0	0	0	1	
			х	х	0	0	0	0	1	0	
											$\downarrow$
			х	х	1	1	1	1	1	0	
			х	х	1	1	1	1	1	1	Larger value

Remark X: Don't Care





#### 12.19 Static Indicator (Two-Byte Command)

This command is used to control the indicator display for the static drive system. Only this command can control the static indicator display, and it operates independently of other display control commands.

One of the electrodes for the static indicator's LCD driver is connected to the FR pin and the other is connected to the FRS pin. We recommend that these status indicator electrodes be implemented in a pattern that is separate from the electrodes used for the dynamic drive. The LCD and the electrodes themselves may deteriorate if the patterns are laid out too close to each other.

The static indicator ON command is a two-byte command that is used in a pair with the static indicator register set command, so be sure to use both commands consecutively. (The static indicator OFF command is a one-byte command.)

#### 12.19.1 Static indicator ON/OFF

When the static indicator ON command is input, the static indicator register set command becomes valid. Once the static indicator ON command has been input, any command other than the static indicator register set command cannot be used. This restriction is cleared once data has been set to the register by the static indicator register set command.

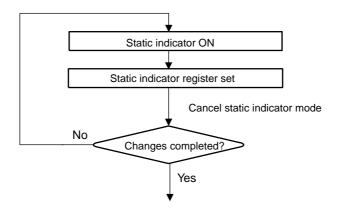
A0	E, /RD	R,/W, /WR	D7	D <sub>6</sub>	D₅	D4	Dз	D2	D1	Do	Static Indicator
0	1	0	1	0	1	0	1	1	0	0	OFF
										1	ON

#### 12.19.2 Static indicator register set

This command sets data to the two-bit static indicator register and then sets the static indicator to blink mode.

A0	E, /RD	R,/W, /WR	D7	D6	D₅	D4	D3	D2	D1	Do	Static Indicator	
0	1	0	х	х	х	х	х	х	0	0	OFF	
									0	1	ON (blinks at one- second interval)	
									1	0	ON (blinks at half- second interval)	
									1	1	ON (always ON)	

#### Figure 12–4. Sequence of Static Indicator Register Set Operations



#### 12.20 Power Save (Compound Command)

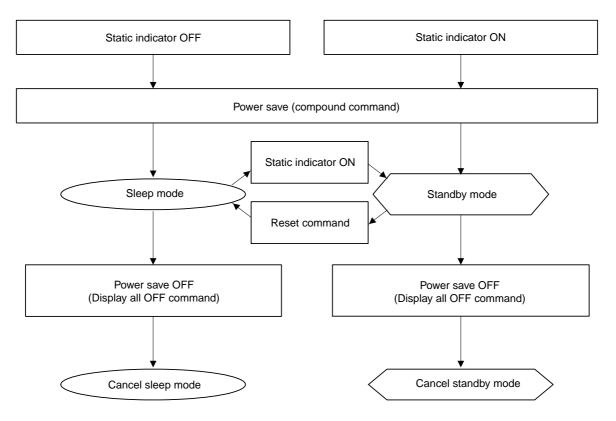
The current consumption can be greatly reduced by entering the power save status by inputting the display all ON command while the display is in OFF mode.

The power save (low power) mode includes two modes; sleep mode and standby mode. Turning the static indicator OFF sets sleep mode and turning it ON sets standby mode.

During either sleep mode or standby mode, the display data is retained as it was before the power save function was activated. Also, access to the display data RAM from the CPU is possible during either mode.

Use the display all OFF command to cancel power save mode.

Figure 12–5. Power Save



### 12.20.1 Sleep mode

During this mode, all LCD operations are stopped and there is no access from the CPU, so current consumption can be reduced almost as low as the static current level. The internal status during sleep mode is as follows.

- (1) The oscillation circuit and LCD power supply circuit are stopped.
- (2) All LCD drive circuits are stopped and both segment and common driver outputs output at the Vss level.

#### 12.20.2 Standby mode

During this mode, all duty LCD display system operations are stopped and only the static drive system for the indicators operate, which reduces the current consumption to the minimum amount needed for static drive. The internal status during standby mode is as follows.

- (1) The LCD's power supply circuit is stopped. The oscillation circuit operates.
- (2) The duty drive system's LCD drive circuit is stopped and both segment and common driver outputs output at the Vss level. The static drive system operates.

When a reset command is executed while in standby mode, it sets sleep mode.

- **Remarks1.** If you are using an external power supply, we recommend that you stop the external power supply circuit's functions when activating the power save function. For example, if you are using an external divided resistor circuit to provide LCD drive voltage at different levels, we recommend that you add a circuit to cut the current flowing on the divided resistor circuit while the power save function is being activated.
  - **2.** The  $\mu$  PD16682A includes the /DOF pin which is used to control blinking LCD displays is set to low level when activating the power save function. The output from /DOF can be used to stop the external power supply circuit's function.
  - **3.** When the display has been set to OFF mode, executing the display all ON command sets power save mode no matter which command is entered afterward.

## 12.21 NOP

This command is used to set NOP (Non-Operation) mode.

A0	E, /RD	R,/W, /WR	D7	D <sub>6</sub>	D5	D4	Dз	D2	D1	Do
0	1	0	1	1	1	0	0	0	1	1

### 12.22 Test

This command is used for IC testing. Do not use this command. If you use it by mistake, either set the /RESET input low or use the reset command or NOP command to cancel the test command setting.

A0	E, /RD	R,/W, /WR	D7	D <sub>6</sub>	D₅	D4	Dз	D <sub>2</sub>	D1	Do
0	1	0	1	1	1	1	х	х	х	х

Remark X: Don't care

Command						nmand o				. ,		Function
Command	A0	/RD	/WR	D7	D <sub>6</sub>	D5	D4	Dз	D <sub>2</sub>	D1	Do	T unction
Display ON/OFF	0	1	0	1	0	1	0	1	1	1	0	Sets LCD's ON/OFF status
	0	'	0		0	'	0		'		1	0: OFF, 1: ON
Display start line set	0	1	0	0	1		Dis	splay sta	art addr	ess		Sets display RAM's
			Ŭ	Ū			2.0	,piaj en				display start line address
Page address set	0	1	0	1	0	1	1		Page a	address		Sets display RAM's page
			-						. 9			address
Column address set	0	1	0	0	0	0	1	High-order column address		ddress	Sets high-order four bits	
(high-order bits)											of display RAM's column	
	]	L									address	
Column address set	0	1	0	0	0	0	0	Low-order column address		ddress	Sets low-order four bits	
(low-order bits)											display RAM's column	
											address	
Status read	0	0	1	0		Status		0	0	0	0	Read status information
Display data write	1	1	0				Write	e data				Writes to display RAM
Display data read	1	0	1				Read	d data				Reads from display RAM
ADC select	0	1	0	1	0	1	0	0	0	0	0	Sets correspondence of
											1	SEG output to display
												RAM address
												0: Normal, 1: Inverted
Display	0	1	0	1	0	1	0	0	1	1	0	Sets normal/inverted
normal/inverted											1	direction of display
Display all ON/OFF	0	1	0	1	0	1	0	0	1	0	0	Sets display all ON
											1	0: Normal display, 1: All
												ON
LCD bias set	0	1	0	1	0	1	0	0	0	1	0	Sets the bias setting of
											1	the LCD drive voltage
												0: 1/9 bias, 1: 1/7 bias
Read modify write	0	1	0	1	1	1	0	0	0	0	0	Specifies incrementation
												of the column address
												During write: +1,
												During read: 0
End	0	1	0	1	1	1	0	1	1	1	0	Cancels read modify write
Reset	0	1	0	1	1	1	0	0	0	1	0	Sets an internal reset
Selects scan	0	1	0	1	1	0	0	0	х	х	х	Selects scan direction for
direction for COM								1	х	х	х	COM outputs
outputs												0: Normal (forward),
												1: Inverted (reverse)

# Table 12–1. List of $\mu$ PD16682A Commands (1/2)

Remark X: Don't care

Command					Corr	mand	code					Function
	A0	/RD	/WR	D7	D6	D₅	D4	D3	D <sub>2</sub>	D1	Do	
Power control set	0	1	0	0	0	1	0	1	Ope	ration n	node	Selects operation mode of internal power supply
Sets V <sub>LC1</sub> output voltage to electronic volume register	0	1	0	0	0	1	0	0		stance t setting		Selects on-chip resistance factor for (Ra/Rb)
Electronic volume mode set	0	1	0	1	0	0	0	0	0	0 1		Sets V <sub>LC1</sub> output voltage to electronic volume
Electronic volume register set	0	1	0	х	х		Elec	tronic v	olume v	value		register
Static indicator ON/OFF	0	1	0	1	0	1	0	1	1	0	0 1	0: OFF, 1: ON
Static indicator register set	0	1	0	х	х	х	х	х	х	Мс	ode	Sets ON mode
Power save												Compound command for setting display OFF and all display ON
NOP	0	1	0	1	1	1	0	0	0	) 1 1		Command for Non- Operation mode
Test	0	1	0	1	1	1	1	х	х	Х	Х	Command used for IC testing Caution Do not use this command.

# Table 12–1. List of $\mu$ PD16682A Commands (2/2)

Remark X: Don't care

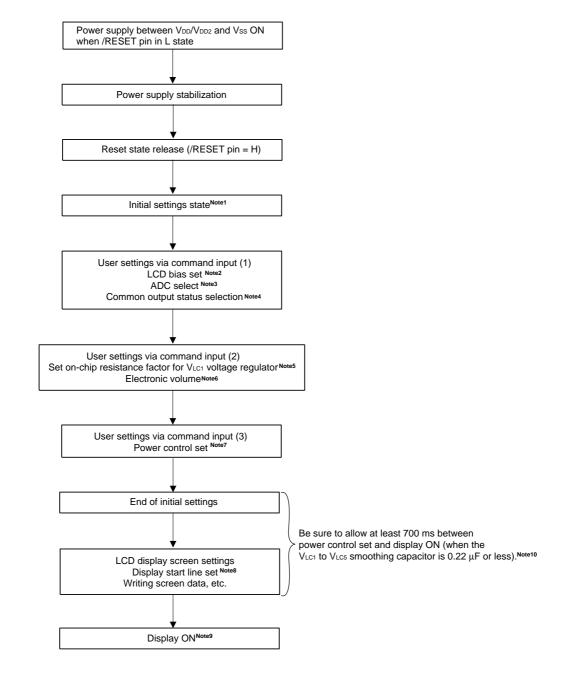
## **13. ACCESS PROCEDURE**

### 13.1 Instruction setting example

### 13.1.1 Initialization setting example (from power application to display ON)

Although a Vss level is output from the SEG and COM LCD drive output pins when power is applied to the IC, if there is electric charge remaining in the smoothing capacitor connected between the driver reference power supply pins (VLc1 to VLc5) and Vss, or if the DC/DC converter's booster voltage does not reach the prescribed booster potential or the levels of the reference power supplies (VLcn) do not reach the prescribed voltages when power is applied, abnormalities such as a temporary screen blackout may occur when the display turns on.

The following power application flow is recommend to avoid the occurrence of abnormal operation when the power is turned on.



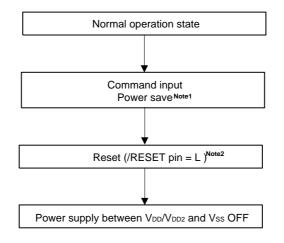
Notes 1. See 11. RESET CIRCUIT.

- 2. See 12.11 LCD Bias Set.
- 3. See 12.8 ADC Select (Segment Driver Direction Select).
- 4. See 12.15 Common Output Status Select.
- 5. See 12.17 Set On-chip Resistance Factor for VLC1 Voltage Regulator.
- 6. See 12.18 Electronic Volume (Two-Byte Command).
- 7. See 12.16 Power Control Set.
- 8. See 12.2 Display Start Line Set.
- 9. See 12.1 Display ON/OFF.
- **10.** This period changes depending on the panel characteristics and the capacitance of the booster/smoothing capacitor. It is recommended to determine this value after sufficient evaluation using the actual device.

### 13.1.2 Example of power OFF

When turning the power of the IC off in the normal operation state (liquid crystal display ON, on-chip power supply circuits operating), because there is electric charge remaining in the power supply level smoothing capacitor connected between the driver reference power supply pins (VLC1 to VLC5) and Vss, power continues to be supplied to the LCD drive circuit and voltage may be applied to the LCD panel from the SEG and COM pins. At this time, the LCD panel may momentarily display data.

Moreover, because the visual quality of the LCD panel may be affected, be sure to turn off the power to the IC in the following sequence.



### Notes 1. See 12.20 Power Save (Compound Command).

**2.** Application of a reset is optional.

\*

## 14. ELECTRICAL SPECIFICATIONS

Absolute Maximum	Ratings	(T <sub>A</sub> = 25°C.	$V_{\rm SS} = 0 V$
	natingo	(17 20 0,	•••••••

Parameter	Symbol	Rating	Unit
Supply voltage	Vdd	-0.3 to +6.0	V
Supply voltage 2 (4x boost)	V <sub>DD2</sub>	–0.3 to +3.75	V
Supply voltage 2 (3x boost)	V <sub>DD2</sub>	-0.3 to +5.0	V
Driver supply voltage	VLCD	-0.3 to +15.0, $V_{\text{DD}} \leq V_{\text{LCD}}$	V
Driver reference supply input voltage	VLC1 to VLC5	−0.3 to V <sub>LCD</sub> +0.3	V
Logic system input voltage	V <sub>IN1</sub>	-0.3 to V <sub>DD</sub> +0.3	V
Logic system output voltage	Vout1	-0.3 to V <sub>DD</sub> +0.3	V
Logic system input/output voltage	VI/01	-0.3 to V <sub>DD</sub> +0.3	V
Driver system input voltage	VIN2	−0.3 to V <sub>LCD</sub> +0.3	V
Driver system output voltage	Vout2	-0.3 to VLCD+0.3	V
Operating ambient temperature	Та	-40 to +85	°C
Storage temperature	Tstg	–55 to +150	°C

Caution Product quality may suffer if the absolute maximum rating is exceeded even momentarily for any parameter. That is, the absolute maximum ratings are rated values at which the product is on the verge of suffering physical damage, and therefore the product must be used under conditions that ensure that the absolute maximum ratings are not exceeded.

## Recommended Operating Range

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Supply voltage	Vdd	1.8		4.5	V
Supply voltage 2 (4x boost)	VDD2	2.4		3.0	V
Supply voltage 2 (3x boost)	VDD2	2.4		4.0	V
Driver supply voltage	VLCD	6	10	12	V
Logic system input voltage	VIN	0		Vdd	V
Driver system input voltage	VLC1 to VLC5	0		VLCD	V

**Remarks 1.** When using an external power supply, be sure to maintain these relations:

 $V_{\text{SS}} < V_{\text{LC5}} < V_{\text{LC4}} < V_{\text{LC3}} < V_{\text{LC2}} < V_{\text{LC1}} \leq V_{\text{LCD}}$ 

**2.** Maintain  $V_{DD} \leq V_{LCD}$  when turning the power on or off.

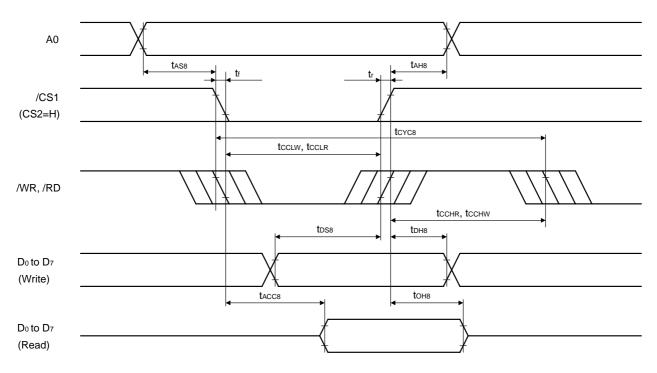
# Electrical Characteristics (unless otherwise specified, T<sub>A</sub> = -40 to +85°C, V<sub>DD</sub> = 2.7 to 3.3 V, during 4x boost mode: V<sub>DD2</sub> = 2.7 to 3.0 V,or V<sub>DD2</sub> = 2.7 to 4.0 V)

Parameter	Symbol	Condition	MIN.	TYP. <sup>Note</sup>	MAX.	Unit
High-level input voltage	VIH		0.8 Vdd			V
Low-level input voltage	VIL				0.2 Vdd	V
High-level input current	Іін1	Except for $D_7(SI)$ , $D_6(SCL)$ , and $D_5$ to $D_0$			1	μA
Low-level input current	lil1	Except for D7(SI), D6(SCL), and D₅ to D₀			-1	μA
High-level output voltage	Vон	Iουτ = -1.5 mA, except OSCout	VDD-0.5			V
Low-level output voltage	Vol	Ioυτ = 4 mA, except OSCouτ			0.5	V
High-level leakage current	Ісон	D⁊(SI), D₀(SCL), and D₅ to D₀ Vin/out = V <sub>DD</sub>			10	μA
Low-level leakage current	Ilol	D⁊(SI), D₀(SCL), and D₅ to D₀ Vin/out = Vss			-10	μA
Common output ON resistance	Rсом	$V_{LCn} \rightarrow COM_n, V_{LCD} \ge 3V_{DD2}, I_{LOL}$ = 50 $\mu A$			2	kΩ
Segment output ON resistance	Rseg	$V_{LCn} \rightarrow SEG_{n}, V_{LCD} \ge 3V_{DD2}, I_{LOL} = 50 \ \mu A$			4	kΩ
Driver voltage (boost voltage)	VLCD	During 3x boost	2.7 Vdd		3.0 Vdd	V
		During 4x boost	3.6 VDD		4.0 Vdd	V
Current consumption (normal mode)	Idd11	fosc = 22 kHz, all display OFF data output, $V_{DD} = V_{DD2} = 3.0$ V during 3x boost mode, $T_A = 25^{\circ}C$		60	110	μA
		fosc = 22 kHz, all display OFF data output, $V_{DD} = V_{DD2} = 3.0 V$ during 4x boost mode, $T_A = 25^{\circ}C$		90	135	μA
Current consumption (high-power mode)	Idd12	fosc = 22 kHz, all display OFF data output, V <sub>DD</sub> = V <sub>DD2</sub> = 3.0 V during 3x boost mode, T <sub>A</sub> = 25°C		105	190	μA
		fosc = 22 kHz, all display OFF data output, $V_{DD} = V_{DD2} = 3.0 V$ during 4x boost mode, $T_A = 25^{\circ}C$		155	230	μA
Current consumption (standby mode)	Idd21	$f_{OSC} = 22 \text{ kHz}, \text{ V}_{DD} = \text{V}_{DD2} = 3.0 \text{ V},$ TA = 25°C		7	15	μA
Current consumption (sleep mode)	Idd22	V <sub>DD</sub> = V <sub>DD2</sub> = 3.0 V, T <sub>A</sub> = 25°C		0.2	5	μA
Oscillation frequency	fosc	$T_A = 25^{\circ}C$ , $V_{DD} = V_{DD2} = 3.0 V \pm 10\%$	17	22	25	kHz

**Note** The TYP. value is a reference value when  $T_A = 25^{\circ}C$ .

# Required timing conditions (unless otherwise specified, T<sub>A</sub> = -40 to +85°C)

## 80 Series CPU



### (VDD = 2.7 to 4.5 V)

Parameter	Symbol	Conditions	MIN.	TYP. <sup>Note</sup>	MAX.	Unit
Address hold time	tанв	A0	0			ns
Address setup time	t <sub>AS8</sub>	A0	0			ns
System cycle time	tсус8		300			ns
Control L pulse /width (/WR)	tcclw	/WR	60			ns
Control L pulse width (/RD)	<b>t</b> CCLR	/RD	120			ns
Control H pulse width (/WR)	tсснw	/WR	60			ns
Control H pulse width (/RD)	<b>t</b> CCHR	/RD	60			ns
Data setup time	t <sub>DS8</sub>	Do to D7	40			ns
Data hold time	tона	Do to D7	15			ns
/RD access time	t <sub>ACC8</sub>	D <sub>0</sub> to D <sub>7</sub> , C <sub>L</sub> = 100 pF			140	ns
Output disable time	tонв	D <sub>0</sub> to D <sub>7</sub> , C <sub>L</sub> = 100 pF	10		100	ns

**Note** The TYP. value is a reference value when  $T_A = 25^{\circ}C$ .

### (V<sub>DD</sub> = 2.4 to 2.7 V)

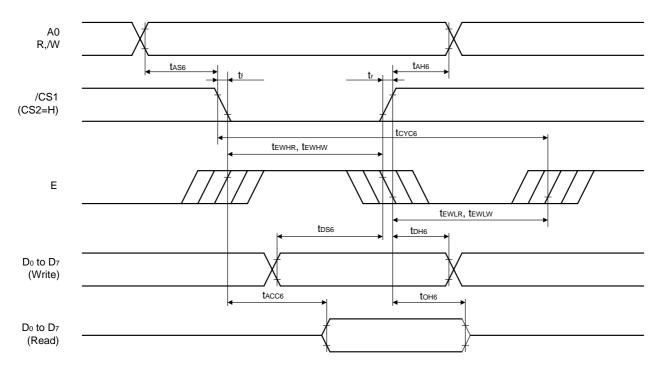
Parameter	Symbol	Conditions	MIN.	TYP. <sup>Note</sup>	MAX.	Unit
Address hold time	tанв	A0	0			ns
Address setup time	t <sub>AS8</sub>	A0	0			ns
System cycle time	tсус8		1000			ns
Control L pulse width (/WR)	tccLw	/WR	120			ns
Control L pulse width (/RD)	tcclr	/RD	240			ns
Control H pulse width (/WR)	tсснw	/WR	120			ns
Control H pulse width (/RD)	<b>t</b> CCHR	/RD	120			ns
Data setup time	t <sub>DS8</sub>	Do to D7	80			ns
Data hold time	tона	Do to D7	30			ns
/RD access time	t <sub>ACC8</sub>	D <sub>0</sub> to D <sub>7</sub> , C <sub>L</sub> = 100 pF			280	ns
Output disable time	tонв	D <sub>0</sub> to D <sub>7</sub> , C <sub>L</sub> = 100 pF	10		200	ns

**Note** The TYP. value is a reference value when  $T_A = 25^{\circ}C$ .

**Remarks 1.** The rise and fall times ( $t_r$  and  $t_f$ ) of input signals are rated at 15 ns or less. When using a fast system cycle time, the rated value range is either ( $t_r + t_f$ ) < ( $t_{CYC8}-t_{CCLW}-t_{CCHW}$ ) or ( $t_r + t_f$ ) < ( $t_{CYC8}-t_{CCLW}-t_{CCHW}$ ).

- 2. All timing is rated based on 20% or 80% of V\_DD.
- 3. tccLw and tccLR are rated as the overlap time when /CS1 is at low level (CS2 = H) and /WR and /RD are also at low level.
- 4. Do to D7 change to output regardless of the state of the E signal when R,/W becomes H in the state of /CS1 = L, CS2 = H (See 5.1.2 (2) 68 Series Parallel Interface.).

## 68 Series CPU



### (V<sub>DD</sub> = 2.7 to 4.5 V)

Paramete	r	Symbol	Conditions	MIN.	TYP. <sup>Note</sup>	MAX.	Unit
Address hold time		t <sub>AH6</sub>	A0	0			ns
Address setup time		t <sub>AS6</sub>	A0	0			ns
System cycle time		tcyc6		300			ns
Data setup time		t <sub>DS6</sub>	Do to D7	40			ns
Data hold time		tdh6	Do to D7	15			ns
Access time		t <sub>ACC6</sub>	Do to D7, CL = 100 pF			140	ns
Output disable time		tон6	Do to D7, CL = 100 pF	10			ns
Enable H pulse width	Read	tewhr	E	120			ns
	Write	tewнw	E	60			ns
Enable L pulse width	Read	tewlr	E	60			ns
	Write	tewlw	E	60			ns

**Note** The TYP. value is a reference value when  $T_A = 25^{\circ}C$ .

## (V<sub>DD</sub> = 2.4 to 2.7 V)

Paramete	r	Symbol	Conditions	MIN.	TYP. <sup>Note</sup>	MAX.	Unit
Address hold time		tah6	A0, R,/W	0			ns
Address setup time		tas6	A0, R,/W	0			ns
System cycle time		tcyc6		1000			ns
Data setup time		t <sub>DS6</sub>	Do to D7	80			ns
Data hold time		t <sub>DH6</sub>	Do to D7	30			ns
Access time		t <sub>ACC6</sub>	D <sub>0</sub> to D <sub>7</sub> , C <sub>L</sub> = 100 pF			280	ns
Output disable time		tон6	D <sub>0</sub> to D <sub>7</sub> , C <sub>L</sub> = 100 pF	10			ns
Enable H pulse width	Read	tewhr	E	240			ns
	Write	tеwнw	E	120			ns
Enable L pulse width	Read	tewlr	E	120			ns
	Write	tewlw	E	120			ns

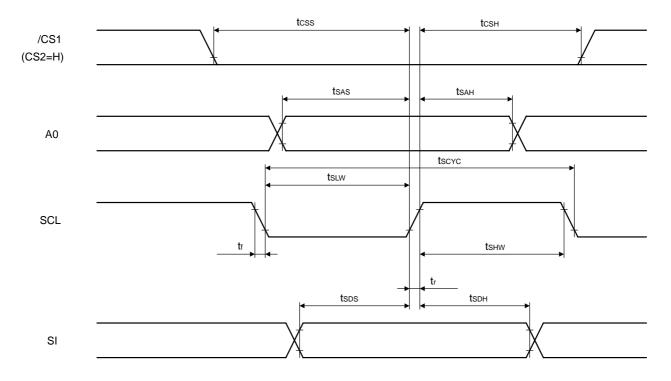
**Note** The TYP. value is a reference value when  $T_A = 25^{\circ}C$ .

**Remarks 1.** The rise and fall times ( $t_r$  and  $t_f$ ) of input signals are rated at 15 ns or less. When using a fast system cycle time, the rated value range is either ( $t_r + t_f$ )  $\leq$  ( $t_{CYC6}-t_{EWLW}-t_{EWHW}$ ) or ( $t_r + t_f$ )  $\leq$  ( $t_{CYC6}-t_{EWLR}-t_{EWHR}$ ).

2. All timing is rated based on 20% or 80% of  $V_{\text{DD}}.$ 

 tewhw and tewlw are rated as the overlap time when /CS1 is at low level (CS2 = H) and E is at high level.

## Serial Interface



## (VDD = 2.7 to 4.5 V)

Parameter	Symbol	Conditions	MIN.	TYP. <sup>Note</sup>	MAX.	Unit
Shift clock cycle	tscyc	SCL	250			ns
SCL H pulse width	tsнw	SCL	100			ns
SCL L pulse width	tslw	SCL	100			ns
Address setup time	tsas	A0	150			ns
Address hold time	tsaн	A0	150			ns
Data setup time	tsos	SI	100			ns
Data hold time	tsdн	SI	100			ns
CS-SCL time	tcss	/CS1,CS2	150			ns
	tсsн	/CS1,CS2	150			ns

**Note** The TYP. value is a reference value when  $T_A = 25^{\circ}C$ .

### (V<sub>DD</sub> = 2.4 to 2.7 V)

Parameter	Symbol	Conditions	MIN.	TYP. <sup>Note</sup>	MAX.	Unit
Shift clock cycle	tscyc	SCL	400			ns
SCL H pulse width	tsнw	SCL	150			ns
SCL L pulse width	tslw	SCL	150			ns
Address setup time	tsas	A0	250			ns
Address hold time	<b>t</b> sah	A0	250			ns
Data setup time	tsps	SI	150			ns
Data hold time	<b>t</b> sdh	SI	150			ns
CS-SCL time	tcss	/CS1,CS2	250			ns
	tcsн	/CS1,CS2	250			ns

**Note** The TYP. value is a reference value when  $T_A = 25^{\circ}C$ .

**Remarks 1.** The rise and fall times (tr and tr) of input signals are rated at 15 ns or less.

2. All timing is rated based on 20% or 80% of V\_DD.

## Common

Parameter	Symbol	Conditions	MIN.	TYP. <sup>Note</sup>	MAX.	Unit
Oscillation frequency	fcL	C∟, When using external input,	17	22	25	kHz
		$T_A = 25^{\circ}C, V_{DD} = V_{DD2} = 3.0 V \pm 10\%$				

**Remarks 1.** The rise and fall times (tr and tr) of input signals are rated at 15 ns or less.

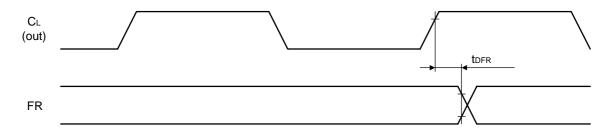
2. The frame time can be determined using the following equation.

1 frame = 1/fosc or 1/fcL x 4 x duty value

Therefore, when fosc and fcL = 22 kHz and the duty value is 1/65:

1 frame = 45.5  $\mu$ s x 4 x 65 = 11.8 ms (approximately 84.6 kHz)

## Output timing for display output control



## (VDD = 2.7 to 4.5 V)

Parameter	Symbol	Conditions	MIN.	TYP. <sup>Note</sup>	MAX.	Unit
FR delay time	<b>t</b> dfr	FR, C∟ = 50 pF		20	80	ns

**Note** The TYP. value is a reference value when  $T_A = 25^{\circ}C$ .

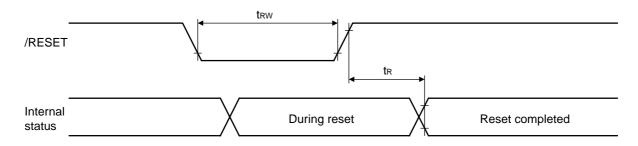
### (V<sub>DD</sub> = 2.4 to 2.7 V)

Parameter	Symbol	Conditions	MIN.	TYP. <sup>Note</sup>	MAX.	Unit
FR delay time	<b>t</b> dfr	FR, C∟ = 50 pF		50	200	ns

Note The TYP. value is a reference value when  $T_A = 25^{\circ}C$ .

Remark All timing is rated based on 20% or 80% of VDD.

## **Reset input timing**



## (V<sub>DD</sub> = 2.7 to 4.5 V)

Parameter	Symbol	Conditions	MIN.	TYP. <sup>Note</sup>	MAX.	Unit
Reset time	tR				1.0	μs
Reset L pulse width	trw	/RESET	1.0			μs

**Note** The TYP. value is a reference value when  $T_A = 25^{\circ}C$ .

## (V<sub>DD</sub> = 2.4 to 2.7 V)

Parameter	Symbol	Conditions	MIN.	TYP. <sup>Note</sup>	MAX.	Unit
Reset time	tR				1.5	μs
Reset L pulse width	trw	/RESET	1.5			μs

**Note** The TYP. value is a reference value when  $T_A = 25^{\circ}C$ .

**Remark** All timing is rated based on 20% or 80% of VDD.

[MEMO]

[MEMO]

### NOTES FOR CMOS DEVICES

## **1** PRECAUTION AGAINST ESD FOR SEMICONDUCTORS

#### Note:

Strong electric field, when exposed to a MOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred. Environmental control must be adequate. When it is dry, humidifier should be used. It is recommended to avoid using insulators that easily build static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work bench and floor should be grounded. The operator should be grounded using wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions need to be taken for PW boards with semiconductor devices on it.

### (2) HANDLING OF UNUSED INPUT PINS FOR CMOS

Note:

No connection for CMOS device inputs can be cause of malfunction. If no connection is provided to the input pins, it is possible that an internal input level may be generated due to noise, etc., hence causing malfunction. CMOS devices behave differently than Bipolar or NMOS devices. Input levels of CMOS devices must be fixed high or low by using a pull-up or pull-down circuitry. Each unused pin should be connected to VDD or GND with a resistor, if it is considered to have a possibility of being an output pin. All handling related to the unused pins must be judged device by device and related specifications governing the devices.

# **③** STATUS BEFORE INITIALIZATION OF MOS DEVICES

#### Note:

Power-on does not necessarily define initial status of MOS device. Production process of MOS does not define the initial operation status of the device. Immediately after the power source is turned ON, the devices with reset function have not yet been initialized. Hence, power-on does not guarantee out-pin levels, I/O settings or contents of registers. Device is not initialized until the reset signal is received. Reset operation must be executed immediately after power-on for devices having reset function.

**Reference Documents** 

NEC Semiconductor Device Reliability/Quality Control System (C10983E) Semiconductor Device Mounting Technology (C10535E)

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